

DEPARTMENT OF ELECTRONICS AND COMMUNICATION ENGINEERING

Scheme of Instruction and Syllabus of

M.E. (E.C.E.)
DIGITAL SYSTEMS
Full Time & PTPG
AICTE Model Curriculum
2021-22



UNIVERSITY COLLEGE OF ENGINEERING
(Autonomous)
Osmania University
Hyderabad – 500 007, TS, INDIA

M.E. (ECE- Digital Systems) Scheme of instructions 2021-22

Type of	Course Code	Course Name	Contact hours per week			Scheme of Examinati on		Credi
course			L	T	P	CI E	SEE	ts
		SEMESTER-I	I				I	
Core-I	EC101	VLSI Design and Technology	3	0	0	30	70	3
Core-II	EC102	Micro Controller Architecture	3	0	0	30	70	3
Programme	70111	Advanced Computer					70	3
	EC111	Architecture	3	0	0	30		
Elective-I	EC112	Field Programmable Gate Arrays						
Programme	EC113	VLSI Testing	3 0		0	30	70	3
		Wireless and Mobile		0				
Elective-II	EC114	Communications						
	A C 021	English for Academic and				30	70	0
	AC 031	Research Writing						
Audit	AC 032	Disaster Management	2	0	0			
course-I	AC 033	Sanskrit for Technical		U	0			
	AC 033	Knowledge						
	AC 034	Value Education						
Lab-I	EC151	Digital Systems Laboratory-I	0	0	3	50	-	1.5
	EC161	Seminar-I	0	0	3	50	-	1.5
MC	EC100	Research Methodology in ECE	3	0	0	30	70	3
		TOTAL	17	0	6	280	420	18
SEMESTER-II								
Core-III	EC103	VLSI Design Verification and Testing	3	0	0	30	70	3
Core-IV	EC104	Design of Fault Tolerant and Testable Systems	3	0	0	30	70	3
Drogramma	EC115	Advanced Communication	3		0	30	70	3
Programme Elective-III		andComputer Networks		0				
	EC116	Internet of Things						
Programme	EC117	Digital Design and PLDs	3 0	0	0	30	70	3
Elective-IV	EC118	Low Power VLSI Design		U	U	30		
Audit course -II	AC 035	Stress Management by Yoga	2	0	0	30	70	0
	AC 036	Personality Development						
		through life enlightenment skills						
	AC 037	Constitution of India						
	AC 038	Pedagogy Studies						
Lab-II	EC152	Digital Systems Laboratory-II	0	0	3	50	-	1.5
	EC162	Seminar-II	0	0	3	50	-	1.5
	EC 070	Mini Project	0	0	6	50	-	3
		TOTAL	14	0	12	300	350	18
SEMESTER-III								
Programme Elective-V	EC119	Analog and Mixed Signal IC Design	3	0	0	30	70	3

	EC120	VLSI Signal Processing						
	EC 121	Applications of Nanotechnology						
Open Elective	OE 941	Business Analytics						
	OE 942	Industrial Safety	3 0		0	30	70	3
	OE 943	Operations Research						
	OE 944	Cost Management of						
		Engineering Projects		0				
	OE 945	Composite Materials						
	OE 946	Waste to Energy						
	OE 947	Internet of Things						
	OE 948	Cyber Security						
Dissertatio	EC181	Major project phase - I	0	0	20	100		10
n	EC161		U	U	20	100	•	10
TOTAL		6	0	20	160	140	16	
SEMESTER-IV								
Dissertatio	EC182	Major project phase - II	0	0	32		200	16
n	LC102		U	U	32	_	200	10
GRAND TOTAL								68

CIE: Continuous Internal Evaluation SEE: Semester End Examination

SEMESTER-I

EC 101

VLSI DESIGN AND TECHNOLOGY

Instruction: 3 periods per week Duration of SEE: 3 hours

CIE: 30 marks SEE: 70 marks

Credits: 3

Objectives:

- To learn the basics of MOS Circuits, its process and understand the operation of MOS devices.
- To impart in-depth knowledge on digital logic design
- To understand and design the High-speed CMOS logic circuits and acquaint the students with the fundamental concepts of memory and interconnects

Outcomes: At the end of this course, students will be able to:

- 1. Able to understand the fabrication process of IC technology
- 2. Able to analysis of the operation of MOS transistor
- 3. Able to design layout of the logic function
- 4. Student can able to design Adders, Multipliers and memories etc.
- 5. Getting the idea of design approach

UNIT - I

Review of MOSFET: MOS operation and CMOS process flow, MOS Threshold voltage, Sub threshold conduction. MOSFETI-V characteristics: Long and short channel effects, MOSFET capacitances, lumped and distributed RC model for interconnects, transmission lines, CMOS inverter: Static characteristics, power consumption, dynamic behavior, buffer design. Design rules, Layouts and stick diagram.

UNIT - II

Combinational logic: Transistor sizing in static CMOS logic gates, static CMOS logic gate sizing considering method of logical effort, dynamic logic, pass-transistor logic and Transmission Gate logic. Sequential logic: Static latches and flip-flops (FFs), dynamic latches and FFs, sense-amplifier based FFs, NORA-CMOS, Schmitt trigger circuit.

UNIT - III

High Speed CMOS Logic Design: Switching Time Analysis, Detailed Load capacitance Calculation, Improving Delay calculation with input slope, Gate sizing for optimal path Delay, Optimizing paths with Logical Effort. Scaling MOS Transistors.

UNIT - IV

Data path Design: Adder, Multiplier, Barrel Shifter, Logarithmic Shifter, Semiconductor Memory Design: Core Memory structure, MOS Decoder, Static RAM cell Design and Content-Addressable Memories (CAM).

UNIT - V

Interconnect Design: Introduction, Interconnect RC Delays, Buffer Insertion very long wires, Interconnect coupling capacitance: Components of Coupling capacitance, Coupling effects on Delay, Crosstalk, Interconnect Inductance. Timing issues: Timing fundamentals, clock distribution and jitter.

- 1 David A Hodges, Horace G Jackson ResveASaleg "Analysis and Design of Digital Integrated circuits" The McGraw Hill Companies 3rd edition, 2006
- 2 Jan M Rabaey, A Chandrakasan, Borvioje N "Digital Integrated Circuits Design Perspective" PHI2nd edition, 2005.
- 3 Neil H E Weste, David Harris, Ayan Banerjee "CMOS VLSI Design a circuit's andsystem perspective" Pearson 3nd Edition 2009.
- 4 Wayne Wolf, "Modern VLSI Design" 3rd ed., 1997, Pearson Education

MICROCONTROLLER ARCHITECTURE

Instruction: 3 periods per week
CIE: 30 marks

Duration of SEE: 3 hours
SEE: 70 marks

Credits: 3

Objectives:

- To study the architecture and pin out of 8051 and understand the instructions and program the 8051.
- To communicate serially with the devices and understand the importance of different peripheral devices & their interfacing to 8051
- To gain knowledge on ARM processors and basic architecture.

Outcomes: At the end of this course, students will be able to:

- 1. Gain comprehensive knowledge about architecture and addressing modes of 8051.
- 2. Write assembly language program in 8051 for various applications.
- 3. Program interrupts and communicate 8051 serially external devices
- 4. Able to analyze and design real world applications and interface peripheral devices to the microcontroller.
- 5. Explain basic concepts of ARM processors.

UNIT – I

8051 Architecture and Programming:

Inside the 8051, Introduction to 8051 Assembly0 Programming, Assembly and Running an 8051 Program, The Program Counter and ROM space in the 8051, 8051 Data types and Directives, 8051 Flag bits and PSW register, 8051 Register banks and Stack, Loop and Jump instructions, Call instructions.

UNIT - II

8051 Programming and Addressing modes:

8051 I/O programming, I/O bit manipulation programming, Immediate and Register addressing modes, Accessing memory using various addressing modes, Bit addresses for I/O and RAM, Extra 128-byte on chip RAM in 8052, Arithmetic instructions, Signed number concepts and Arithmetic operations, Logic and Compare instructions, Rotate instruction and Data serialization, BCD, ASCII and other application programs.

UNIT - III

Timer, Serial communication and Interrupt programming: Programming 8051 timers, Counter programming, Programming timers 0 and 1 in 8051 C, Basics of Serial Communication, 8051 Connection to RS232, 8051 Serial Port programming in Assembly, 8051 Interrupts, Programming Timer Interrupts, Programming External Hardware interrupts, Programming the Serial Communication Interrupt.

UNIT - IV

LCD interfacing, Keyboard interfacing, Parallel and Serial ADC, DAC Interfacing, Relays and Optoisolators, Stepper Motor interfacing, DC Motor interfacing and PWM

UNIT - V

ARM Processors fundamentals: Registers, Current Program Status Register, Pipeline, Exceptions, Interrupts and the Vector Table, Core Extensions, Architecture Revision, ARM Processor families.

- Mohammad Ali Mazidi, Rolin D McKinley, Janice G Mazidi, "The 8051 Microcontroller and Embedded Systems", Second Edition, Prentice Hall
- 2 Andrew N.Sloss, Domnic Symes, Chris Wright, "ARM system developers guide", Elsevier publications.
- 3 Kenneth Ayala, "The 8051 microcontroller", third edition, Penram international publications

ADVANCED COMPUTER ARCHITECTURE (PROGRAM SPECIFIC ELECTIVE – I)

Instruction: 3 periods per week Duration of SEE: 3 hours

CIE: 30 marks SEE: 70 marks

Credits: 3

Objectives:

• To Design Basic Data Path Unit (DPU) and Control Unit (CU) and to Familiarize with Parallel Processing Architectures

- To Develop Open CL Programming Environment and developing Kernel Programming
- To Know Heterogeneous Architectures

Outcomes: At the end of this course, students will be able to

- 1. To Realize Data Path Unit (DPU) and Control Unit (CU)
- 2. To Analyze the Performance of Multi-Core Architectures
- 3. To Demonstrate OpenCL Programs for real time applications
- 4. To Implement Kernels for Heterogeneous Architectures in OpenCL
- 5. To List and Describe the Challenges in Advanced Parallel Processing Architectures

UNIT - I

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Processor Design:

CPU Design— CPU Organization — Data Path Design: Fixed Point Booth's Multiplier, Restoring Division Unit and Non-Restoring Division Unit.

Memory Hierarchy - Virtual Memory - Cache Memory

Control Unit Design - Hardwired Control Unit Design of Basic CPU.

Case Studies: Verilog HDL Implementation of Booth's Multiplication, Restoring and Non-Restoring Division and Hardwired Control Unit Realization of Basic CPU

UNIT - II

Multi Core Architectures:

RISC, CISC, Flynn's Classification, Instruction Level Parallelism: Super Scalar, VLIW and EPIC architectures. Scalable, Multithreaded and Dataflow Architectures: Principles of Multithreading, Fine-Grain Multithreading, Scalable and Multithreaded Architectures and Dataflow and Hybrid Architectures.

Case Studies: Threads and OpenMP

UNIT - III

Accelerated Architectures:

GPU: nVidia and AMD Architecture – GPU memory and Scheduling, Parallel Programming Development and Environment: MPI – CUDA – OpenCL: Introduction, Platform and Devices, Execution Environment and Memory Model

Case Studies: OpenCL programming

UNIT - IV

Low Power Architectures: System on Chip Architectures – Raspberry-Pi, nVidia SoC – Basics of Kernels: Kernels, Work-items, Work-groups and Execution Domain, OpenCL Synchronization

Case Studies: Programming on Raspberry Pi.

UNIT - V

Advances in Parallel Processor Architectures:

Hybrid Architectures— Issues and Challenges in Heterogeneous Computing, Schedulers, Process Synchronization and Programming

Virtualization—Processor and Memory

Case Studies: Hybrid Programming using CPU and GPU

- Hayes John P, "Computer Architecture and organization," 3rd edition, McGraw Hill Education, 1998.
- William Stallings, "Computer Organization and Architecture: Designing for Performance", 8th edition, PHI, 2007.
- 3 Hwang and Naresh Jotwani, "Advanced Computer Architecture: Parallelism, Scalability and Programmability," McGraw Hill Education, 2017.
- 4 Benedict Gaster, Lee Howes, David R. Kaeli, Perhaad Mistry and Dana Schaa, "*Heterogeneous Computing with OpenCL*," Morgan Kaufmann Publications, 2011.

FIELD PROGRAMMABLE GATE ARRAYS (PROGRAM SPECIFIC ELECTIVE – I)

Instruction: 3 periods per week
CIE: 30 marks

Duration of SEE: 3 hours
SEE: 70 marks

Credits: 3

Objectives:

• Describe Application Specific IC (ASIC) fundamentals and study various types of FPGAs Architectures.

- Design a digital circuit and implement using FPGA and understand Interconnection, Placement and Routing schemes.
- Learn Verification and testing schemes.

Outcomes: At the end of this course, students will be able to:

- 1. Identify various types of FPGAs Architectures.
- 2. Design FPGA based system for engineering applications
- 3. Implement prototype digital systems using design tools.
- 4. Calculation of interconnection delays of Application Specific IC.
- 5. Apply simulators and testing prototype design systems.

UNIT - I

Introduction to ASIC's: Types of ASIC's, ASIC design flow, Economies of ASIC's, Programmable ASIC's: Introduction to CPLD and FPGA. Programming technologies, FPGA Design cycle, Implementation tools: Simulation and synthesis, Applications of FPGAs.

UNIT - II

Commercially available CPLD's and class of FPGA's: FPGA logic cell for XILINX, ALTERAand ACTEL ACT, Technology trends, Programmable I/O blocks, FPGA interconnect: Routing resources, FPGA design flow, Dedicated Specialised components of FPGAs.

UNIT – III

FPGA physical design: CAD tools, FPGA Partitioning, Partitioning methods. Floor planning: Goals and objectives, I/O, Power and clock planning, Low-level design entry.

UNIT - IV

Placement: Goals and objectives, Placement algorithms: Min-cut based placement, Iterative Improvement and simulated annealing.

Routing: Global routing: Goals and objectives, Global routing methods, Back-annotation. Elmore's constant, RC delay and parasitic capacitance,

Detailed Routing: Goals and objectives, Channel density, Segmented channel routing, Maze routing, Clock and power routing, Circuit extraction and DRC.

UNIT - V

Verification and Testing: Verification: Logic simulation, Design validation, Timing verification. Testing concepts: Failures, Mechanism and faults, Fault coverage.

Design Applications: General Design issues, Counter Examples, A Fast DMA controller, Designing adders and accumulators with Xilinx Architecture.

- 1 Michael John Sebastian Smith, "Application Specific Integrated Circuits", Pearson Education Asia, 3rd edition 2001
- Pak and Chan, Samiha Mourad, "Digital Design using Field Programmable Gate Arrays", Pearson Education, 1st edition, 2009.
- 3 S. Trimberger, Edr, "Field Programmable Gate Array Technology", Kluwer Academic Publications, 1994.
- 4 John V. Oldfield, Richard C Dore, "Field Programmable Gate Arrays", Wiley Publications.

VLSI TESTING (PROGRAM SPECIFIC ELECTIVE – II)

Instruction: 3 periods per week Duration of SEE: 3 hours

CIE: 30 marks SEE: 70 marks

Credits: 3

Objectives:

• To understand faults, fault models in digital systems and understand fault diagnosis

- To understand various test generation methods for combinational and sequential systems
- To understand various DFT architectures and study about various test algorithms

Outcomes: At the end of this course, students will be able to:

- 1. Design fault models and fault simulation methods
- 2. Generate tests for the given faulty circuits
- 3. Test various combinational circuits and sequential circuits
- 4. Test PLAs and develop algorithms
- 5. Diagnose a system

UNIT – I

Introduction to testing: Faults in digital circuits, Modeling of faults, Logical Fault Models, Fault detection, Faultlocation, Fault dominance, Logic Simulation, Types of simulation, Delay models, Gate levelEvent-driven simulation

UNIT - II:

Test Generation for Combinational and Sequential circuits: Test generation for combinational logic circuits, Testable combinational logic circuit design, Test generation for sequential circuits, and design of testable sequential circuits.

UNIT – III

Design for Testability: Design for Testability, Ad-hoc design, Generic scan-based design, Classical scan-based design, System level DFT approaches.

UNIT - IV

Self-Test and test algorithms: Built-In Self-Test, Test pattern generation for BIST, BIST Architectures, test generation algorithms for PLAs, testable PLA designs- concurrent and parity testable PLAs

UNIT - V

Fault Diagnosis: Logic Level Diagnosis, Diagnosis by UUT reduction, Fault Diagnosis for Combinational Circuits, expert system for diagnosis, Effect-cause analysis, System Level Diagnosis.

- M. Abramovici, M.A. Breuer and A.D. Friedman, "Digital Systems and Testable Design", Jaico Publishing House, 2002.
- M.L. Bushnell and V.D. Agrawal, "Essentials of Electronic Testing for Digital, Memory and Mixed -Signal VLSI Circuits", Kluwer Academic Publishers, 2002.
- 3 P.K. Lala, "Digital Circuit Testing and Testability", Academic Press, 2002.
- 4 A.L. Crouch, "Design Test for Digital IC's and Embedded Core Systems", Prentice Hall International, 2002

WIRELESS AND MOBILE COMMUNICATIONS (PROGRAM SPECIFIC ELECTIVE – II)

Instruction: 3 periods per week Duration of SEE: 3 hours

CIE: 30 marks SEE: 70 marks

Credits: 3

Objectives:

• An overview of key wireless technologies: Various generations of mobile communications for voice and data, cordless, paging, fixed and mobile broadband wireless systems, and beyond

- Wireless system design fundamentals: channel assignment, handoffs, interference, frequency reuse, capacity planning, large-scale fading, and Outdoor, Indoor propagation models and Path loss, small-scale fading, multipath, reflection, diffraction, scattering and Various statistical models for small-scale fading study
- Various Diversity techniques, Equalizers used in communication receivers, Multiple Access techniques and their applications in wireless networks

Outcomes: At the end of this course, students will be able to:

- 1. Develop design models for cellular systems.
- 2. Analyze the various Large-scale fading effects in designing propagation models for Mobile communications in Outdoor environments.
- 3. Analyze the various types of Small-scale fading, measurement techniques, Parameters of multi-path radio and Statistical models.
- 4. Understand Various Diversity techniques and Equalizers used in communication receivers
- 5. Develop the design models for various multiple access techniques and understand their spectral efficiencies.

UNIT – I

Introduction to Wireless Communication Systems and the Cellular Concept

Evolution of Mobile Radio Communications, Examples of Wireless Communication Systems, Overview of 1G,2G, 2.5 G,3 G, 4G and 5G Cellular networks.

The Cellular Concept: Introduction, Frequency Reuse, Channel Assignment Strategies, Handoff Strategies, Interference and System Capacity, Improving Coverage and Capacity in cellular systems.

UNIT - II

Mobile Radio Propagation: Large-Scale Path Loss: Introduction to Radio wave propagation, Free space propagation model, Relating Power to Electric Field, the three basic propagation mechanisms- Reflection, Ground Reflection (Two Ray) model, Diffraction, Scattering.

Outdoor propagation models: Longley-Rice model, Okumura model, Hata model, PCS Extension to Hata model, Walfisch and Bertoni Model, Wideband PCS Microcell model.

Indoor propagation models: Partition losses (same floor), Partition losses between floors, Log-distance path loss model, Ericsson multiple breakpoint model, Attenuation factor model, and Signal penetration into buildings.

UNIT – III

Mobile Radio Propagation: Small Fading and Multipath: Small scale multipath propagation, Factors influencing small scale fading, Doppler shift, Small scale multipath Measurements-Direct RF Pulse System, Spread Spectrum Sliding correlator Channel Sounding, Frequency Domain Channels Sounding, Parameters of Mobile multipath channels, Types of Small Scale Fading, Statistical models for multipath Fading Channels-Clarke's model for flat fading, spectral shape due to Doppler, Level Crossings and Fading Statistics, Two-ray Rayleigh Fading model.

UNIT - IV

Equalization and Diversity: Introduction, Fundamentals of Equalization, Training a Generic Adaptive Equalizer, Equalizers in a communication Receiver, Linear Equalizers, Nonlinear Equalization-Decision Feedback Equalization (DFE), Maximum Likelihood Sequence Estimation (MLSE) Equalizer, Algorithms for adaptive equalization

Diversity Techniques: Practical Space Diversity Considerations, Selection Diversity, Scanning Diversity, Maximal Ratio Combining, Equal Gain Combining, Polarization Diversity, Frequency Diversity, Time Diversity, RAKE Receiver.

UNIT - V

Multiple Access Techniques for Wireless Communications: FDMA, TDMA, Spread Spectrum Multiple Access-FHMA and CDMA, SDMA, Spectral efficiency analysis for Multiple Access Technologies: FDMA, TDMA and CDMA Comparison of these technologies based on their signal separation techniques, advantages, disadvantages and application areas.

- 1 Theodore, S. Rappaport, "Wireless Communications, Principles and Practice", 2nd Ed., 2002, PHI publication.
- 2 2. Andrea Goldsmith, "Wireless Communications", 2005, Cambridge University Press.
- 3 Kaveh pah Laven and P.Krishna Murthy, "Principles of Wireless networks", 2002, PE.
- 4 P.Nicopolitidis, M.S.Obaidat, G.I.Papadimitriou, A.S.Pomportsis, "Wireless Networks", 200, John Wiley & Sons Pte Ltd.
- 5 Ashok Raj, "Wireless Communication", First Edition, 2014, Khanna Publishers.

RESEARCH METHODOLOGY IN ECE

Instruction: 3 periods per week
CIE: 30 marks

Duration of SEE: 3 hours
SEE: 70 marks

Credits: 3

Objectives:

- To know the motivation on research philosophy and processes in general.
- To be able to formulate the problem statement and prepare research plan for the problem under investigation through literature.
- To be able to apply various techniques for data analysis and patenting

Outcomes:

- 1. Students able to understand research methodology and problems
- 2. Able to define the techniques involved in defining problem
- 3. Able to Developing a Research plan and research set up
- 4. Able to analyze the collection of data and statistical analysis
- 5. Able to have knowledge on writing the report and patenting

UNIT - I

Objectives and Types of research: Objectives and Motivation of research-types of research-Research approaches – Significance of Research-Research Methods versus Methodology-Research and Scientific method-Importance of research methodology – Research process-criteria of good research-Problems encountered by Researchers in India-benefits to society in general.

UNIT - II

Research formulation: Defining and formulating the research problem, selecting the problem, importance of literature review in define a problem, literature review, primary and secondary sources, reviews, monograms, patents, research data bases web as a source, identifying gap areas from literature review and research data bases, devilment of working hypothesis

UNIT - III

Research Design and methods: Meaning of research design - need of research design-features of a gooddesign- important concepts relating to research design- different research designs- BasicPrinciples of experimental designs- Developing a Research plan-Exploration, descriptions diagnosis and experiment

UNIT - IV

Execution of the research and data collection: Aspect of method validation, observation and collection of data, methods of data collection, sampling methods, data processing and analysis, strategies and tool, data analysis with statistical packages (sigma STAT, SPSS for student test t-test, ANOVA, etc.) hypothesis testing, generalization and interpretation.

UNIT – V

Reporting and thesis writing: Structure and components of scientific reports, types of report, technical report and thesis. Thesis writing-different steps and software tools (word processing) in the design and preparation of thesis, layout, structure (chapter plan) and language of typical reports, illustrations and tables, bibliography, referencing and footnotes. Use of visual aids.

Patenting: The Basics of the Patent System, Patent Law, How to Read a Patent, Protecting Invention and Planning Patent Filing, Preparing Patent Application.

- 1 C.R.Kothari, "Research methodology, Methods & technique", New age international publishers, 2004.
- 2 R.Ganesan, "Research Methodology for Engineers", MJP Publishers: Chennai, 2011.
- P.Ramdass and A.Wilson Aruni, "Research and Writing across the disciplines", MJP Publishers, Chennai 2009
- 4 Matthew Y Ma, "Fundamentals of Patenting and Licensing for Scientists and Engineers" 2nd Edition 2015

AC 031

ENGLISH FOR ACADEMIC AND RESEARCH WRITING (AUDIT COURSE-I)

Instruction: 2 periods per week Duration of SEE: 3 hours

CIE: 30 marks SEE: 70 marks

Credits: 00

Objectives: *To expose the students to...*

• Features of Academic writing; different kinds of Academic writing

• Some academic writing skills; the research process; the structure of a research document

Outcomes: At the end of this course, students will be able to:

- 1. Academic writing features; Academic writing kinds; Important academic writing skills
- 2. The process of research; general research document structure

UNIT - I

Features of Academic Writing

Language: Clear, Correct, Concise, Inclusive; **Tone**: Formal, Objective, Cautious; **Style**: Appropriate, Accurate, Organized; **Ethics**: Honesty, Integrity, Responsibility, Accountability

UNIT - II

Kinds of Academic Writing: Essays, Reports, Reviews, Abstracts, Proposals

UNIT - III

Academic Writing Skills

Paraphrasing; Summarizing; Quoting; Rewriting; Expansion

UNIT - IV

Research Process

Selection of Topic, Formulation of Hypothesis, Collection of Data, Analysis of Data, Interpretation of Data, Presentation of Data

UNIT - V

Structure of a Research Document

Title, Abstract, Introduction, Literature Survey, Methodology, Discussion, Findings/Results, Conclusion, Documenting Sources (IEEE style)

- Bailey, S. (2014). *Academic writing: A handbook for international students*. Routledge.
- 2 Gillett, A., Hammond, A., &Martala, M. (2009). *Inside track: Successful academic writing*. Essex: Pearson Education Limited.
- 3 Griffin, G. (2006). *Research methods for English studies*. Edinburgh University Press.
- 4 Silyn-Roberts, Heather. (2013). Writing for Science and Engineering: Papers, Presentations and Reports (2ndEd.). Elsevier.
- 5 Lipson, Charles (2011). *Cite right: A quick guide to citation styles; MLA, APA, Chicago, the sciences, professions, and more* (2ndEd.). Chicago [u.a.]: University of Chicago Press.

AC 032

DISASTER MANAGEMENT (AUDIT COURSE-I)

Instruction: 2 periods per week Duration of SEE: 3 hours

CIE: 30 marks SEE: 70 marks

Credits: 00

Objectives:

• To impart knowledge in students about the nature, causes, consequences and mitigation measures of the various natural disasters

- To enable the students to understand risks, vulnerabilities and human errors associated with human induced disasters
- To enable the students to understand and assimilate the impacts of any disaster on the affected area depending on its position/ location, environmental conditions, demographic, etc.

Outcomes: At the end of this course, students will be able to:

- 1. Learn to demonstrate a critical understanding of key concepts in disaster risk reduction
- 2. Humanitarian response
- 3. Critically evaluate disaster risk reduction and humanitarian response policy and Practice from multiple perspectives.
- 4. Develop an understanding of standards of humanitarian response and practical relevance in specific types of disasters and conflict situations.
- 5. Critically understand the strengths and weaknesses of disaster management approaches, planning and programming in different countries, particularly their home country or the countries they work in.

UNIT – I

Introduction: Disaster: Definition, Factors and Significance; Difference between Hazard and Disaster; Natural and Manmade Disasters: Difference, Nature, Types and Magnitude.

UNIT – II

Repercussions of Disasters and Hazards: Economic Damage, Loss of Human and Animal Life, Destruction of Ecosystem.

Natural Disasters: Earthquakes, Volcanisms, Cyclones, Tsunamis, Floods, Droughts and Famines, Landslides and Avalanches, Man-made disaster: Nuclear Reactor Meltdown, Industrial Accidents, Oil Slicks and Spills, Outbreaks of Disease and Epidemics, War and Conflicts.

UNIT - III

Disasters Prone Areas in India: Study of Seismic Zones; Areas Prone to Floods and Droughts, Landslides and Avalanches; Areas Prone to Cyclonic and Coastal Hazards with Special Reference to Tsunami; Post-Disaster Diseases and Epidemics

UNIT - IV

Disaster Preparedness and Management

Preparedness: Monitoring of Phenomena Triggering A Disaster or Hazard; Evaluation of Risk: Application of Remote Sensing, Data From Meteorological and OtherAgencies, Media Reports: Governmental and Community Preparedness.

UNIT - V

Risk Assessment

Disaster Risk: Concept and Elements, Disaster Risk Reduction, Global and NationalDisaster Risk Situation. Techniques of Risk Assessment, Global Co-Operation in Risk Assessment and Warning, People's Participation in Risk Assessment. Strategies for Survival.

UNIT - VI

Disaster Mitigation

Meaning, Concept and Strategies of Disaster Mitigation, Emerging Trends in Mitigation. Structural Mitigation and Non-Structural Mitigation, Programs of Disaster Mitigation in India.

- 1 R. Nishith, Singh AK, "Disaster Management in India: Perspectives, issues and strategies", New Royal Book Company.
- 2 Sahni, Pardeep (Eds.), "Disaster Mitigation Experiences and Reflections", PHI, New Delhi
- Goel S. L., "Disaster Administration and Management Text and Case Studies", Deep & Deep Publication Pvt. Ltd., New Delhi.

AC 033

SANSKRIT FOR TECHNICAL KNOWLEDGE (AUDIT COURSE-I)

Instruction: 2 periods per week Duration of SEE: 3 hours

CIE: 30 marks SEE: 70 marks

Credits: 00

Objectives:

• To get a working knowledge in illustrious Sanskrit, the scientific language in the world

- Learning of Sanskrit to improve brain functioning
- Learning of Sanskrit to develop the logic in mathematics, science & other subjects
- *enhancing the memory power*
- The engineering scholars equipped with Sanskrit will be able to explore the huge knowledge from ancient literature

Outcomes: At the end of this course, students will be able to:

- 1. Understanding basic Sanskrit language
- 2. Ancient Sanskrit literature about science & technology can be understood
- 3. Being a logical language will help to develop logic in students

UNIT - I

- Alphabets in Sanskrit,
- Past/Present/Future Tense,
- Simple Sentences

UNIT - II

- Order
- Introduction of roots
- Technical information about Sanskrit Literature

UNIT - III

• Technical concepts of Engineering-Electrical, Mechanical, Architecture, Mathematics

- 1 "Abhyaspustakam" Dr. Vishwas, Samskrita-Bharti Publication, New Delhi
- ² "Teach Yourself Sanskrit" Prathama Deeksha-Vempati Kutumbshastri, Rashtriya SanskritSansthanam, New Delhi Publication
- 3 "India's Glorious Scientific Tradition" Suresh Soni, Ocean books (P) Ltd., New Delhi.

AC 034

VALUE EDUCATION

Instruction: 2 periods per week Duration of SEE: 3 hours

CIE: 30 marks SEE: 70 marks

Credits: 00

Objectives: Students will be able to

• Understand value of education and self- development

• *Imbibe good values in students*

• Let the should know about the importance of character

Outcomes: At the end of this course, students will be able to:

- 1. Knowledge of self-development
- 2. Learn the importance of Human values
- 3. Developing the overall personality

UNIT – I

Values and self-development –Social values and individual attitudes. Work ethics, Indian vision of humanism. Moral and non- moral valuation. Standards and principles. Value judgements

UNIT - II

Importance of cultivation of values. Sense of duty. Devotion, Self-reliance. Confidence, Concentration. Truthfulness, Cleanliness. Honesty, Humanity. Power of faith, National Unity. Patriotism. Love for nature, Discipline

UNIT - III

Personality and Behaviour Development - Soul and Scientific attitude. Positive Thinking. Integrity and discipline. Punctuality, Love and Kindness. Avoid fault Thinking. Free from anger, Dignity of labour. Universal brotherhood and religious tolerance. True friendship. Happiness Vs suffering, love for truth. Aware of self-destructive habits. Association and Cooperation.

UNIT - IV

Doing best for saving nature, Character and Competence –Holy books vs Blind faith, Self-management and Good health. Science of reincarnation. Equality, Nonviolence, Humility, Role of Women. All religions and same message. Mind your Mind, Self-control. Honesty, Studying effectively

References:

1 Chakroborty, S.K., "Values & Ethics for organizations Theory and practice", Oxford University Press, New Delhi, 1998.

DIGITAL SYSTEM LABORATORY - I

Instruction: 3 periods per week

CIE: 50 marks

Duration of SEE: -
SEE: --

Credits: 1.5

Objectives:

• Design CMOS Digital Circuits

- Develop 8051 programs in Keil Software
- Interface real time devices with 8051

Outcomes: At the end of this course, students will be able to:

- 1. Design and Analyze CMOS Digital Circuits
- 2. Model VLSI Interconnects
- 3. Acquaint with Keil Software
- 4. Implement 8051 Programs
- 5. Demonstrate Real Time interfacing with 8051

CYCLE-1

VLSI Design and Technology:

- 1. Design of CMOS Inverter &two input NAND Gate.
- 2. Design of Half Adder using NAND Gates
- 3. Design a Full Adder using transmission gate logic.
- 4. Design a Schmitt trigger circuit using CMOS logic
- 5. Design of 4-bit Adder using Full Adder.
- 6. Design a 4bit barrel shifter
- 7. Design of 4-bit thermometer to Binary Code converter.
- 8. Design and draw the layout of above Digital Circuits.
- 9. Analyze a two-level RC interconnect circuit for a step input
- 10. Analyze a tree level inductive interconnect model circuit

CYCLE-2:

Part A: Simulation of basic 8051 programs using Keil uvision

- 1. Data Transfer -Block move, Exchange, Sorting, Finding largest element in an array.
- 2. Arithmetic Instructions -Addition/subtraction, multiplication and division, square, Cube –(16bits Arithmetic operations –bit addressable).
- 3. Counters
- 4. Boolean & Logical Instructions (Bit manipulations)
- 5. Conditional CALL & RETURN
- 6. Code conversion: BCD -ASCII; ASCII -Decimal; Decimal -ASCII
- 7. HEX -Decimal and Decimal –HEX

- 8. Programs to generate delay, Programs using serial port and on-Chip timer /Counter
- Part B: Interfacing Programs Using Keil µvision Software & 8051 µc Development Board
 - 1. Interfacing of LEDs to 8051 microcontrollers
 - 2. 7 Segment Display
 - 3. LCD
 - 4. Keypad
 - 5. DAC
 - 6. Stepper Motor

SEMINAR - I

Instruction: 3 periods per week

CIE: 50 marks

Duration of SEE: -
SEE: --

Credits: 1.5

Outcomes: At the end of this course, students will be able to:

- 1. Develop the habit of referring the journals for literature review.
- 2. *Understand the gist of the research paper.*
- *3. Identify the potential for further scope.*
- 4. Present the work in an efficient manner.
- 5. Write the documentation in standard format.

Seminar topics may be chosen by the students with advice from the faculty members and the student shall read further relevant articles in the domain.

The seminar must be clearly structured and the power point presentation shall include following aspects:

- 1. Introduction to the field
- 2. Literature survey
- 3. Consolidation of available information
- 4. Summary and Conclusions
- 5. References

Each student is required to:

- 1. Deliver the seminar for a maximum duration of 30 minutes, where the presentation should be for 20 minutes in PowerPoint, followed by Question and Answers session for 10 minutes.
- 2. Submit the detailed report of the seminar in spiral bound in a précised format as suggested by the Department.

Guidelines for awarding marks					
S. No.	Description	Max. Marks			
1	Contents and relevance	10			
2	Presentation skills	10			
3	Preparation of PPT slides	05			
4	Questions and answers	05			
5	Report in a prescribed format	20			

Note:

- 1. The seminar presentation should be a gist of at least five research papers from **Peer-reviewed** or **UGC recognised** journals.
- 2. The seminar report should be in the following order: Background of work, literature review, techniques used, prospective deliverables, discussion on results, conclusions, critical appraisal and reference.
- 3. At least two faculty members will be associated with the seminar presentation to evaluate and award marks.
- 4. Attendance of all the students for weekly seminar presentations is compulsory. If the student fails to secure minimum attendance as per O.U. rules, the marks awarded in the seminar presentation shall remain void.

SEMESTER-II

EC 103

VLSI DESIGN VERIFICATION AND TESTING

Instruction: 3 periods per week Duration of SEE: 3 hours

CIE: 30 marks SEE: 70 marks

Credits: 3

Objectives:

• To Develop Structural, Dataflow and Behavioral Modeling of Verilog HDL.

- To Know Basics of System Verilog and Familiarize with Object Oriented Programming
- To Explore Randomization and Threads in System Verilog an also, to Know Test Coverage in System Verilog

Outcomes: At the end of this course, students will be able to:

- 1. To Realize and Verify Combinational and Sequential Circuits in Verilog HDL
- 2. To Construct User Defined Data Types in System Verilog
- 3. To Create Object Oriented Programming Environment
- 4. To Demonstrate Randomization and Coverage Concepts of System Verilog
- 5. To Propose Efficient Testable Digital Systems in System Verilog

UNIT – I

Introduction to Verilog

Verilog Basics: Modules and Ports, Structural, Data Flow, Behavioral and switch level Modeling, Tasks and Functions, Logic Synthesis, Timing Delays.

Static timing analysis: Setup time & hold time violations, clock skew.

UNIT - II

Introduction to Verification

Verification guidelines: Verification Process, Test bench creation, Significance of Verification, Verilog for verification.

Introduction to System Verilog: Advantages over Verilog, Methodology, Randomization basics, Coverage basics

Data Types: Built-in data types, Fixed and dynamic Arrays, Queues, Associative Arrays, Enumerated data types, Procedural statements, Time values.

UNIT - III

Introduction to Object Oriented Programming (OOP): Communication between the Test bench and DUT, Interface Construct, Stimulus Timing, Interface Driving and Sampling, Programming block basics, System Verilog assertions.

OOP: Object Oriented Programming significance and advantages, classes, objects handles, methods, Static and Global Variables, using one class inside another class, Dynamic objects, copying objects, Public Vs Local and Building a test bench, Tasks and Functions.

UNIT - IV

Verification using System Verilog

Randomization: Significance, randomization in system Verilog, Constraint randomization, atomic stimulus generation, random number generation, constraint tips and techniques. *Threads:* Threads, inter process communication, Events, Semaphores, Mailboxes virtual methods, Copying an Object, Inheritance, Abstract Classes and Pure Virtual Methods. Case study using Verification Machine.

UNIT - V

Advanced System Verilog: Callbacks, Parameterized Classes, Static and Singleton Classes Coverage: Introduction, Coverage Types, Functional Coverage Strategies, cover group, defining cover groups in classes, Data sampling, coverage points, Coverage methods, Cross coverage, Case study using Universal Verification Machine (UVM).

- 1 Ming-Bo Lin., "Digital System Designs and Practices Using Verilog HDL and FPGAs", Wiley India, 2008.
- 2 Samir Palnitkar, "Verilog HDL: A Guide to Digital Design and Synthesis", Pearson Education, 2005.
- 3 Christ Spear and Greg Tumbush, "System Verilog for Verification", 3rd ed., Springer, 2012.

DESIGN OF FAULT TOLERANT AND TESTABLE SYSTEMS

Instruction: 3 periods per week Duration of SEE: 3 hours

CIE: 30 marks SEE: 70 marks

Credits: 3

Objectives:

• To know about Reliability Concepts and basic concepts of self-checking circuits,

- To learn about Basic concepts of Testability, ATG and design of testability
- To know the use of control and Syndrome Testable Designs

Outcomes: At the end of this course, students will be able to:

- 1. Understand reliability of various architectures
- 2. Design fail safe circuits
- 3. Implement algorithms for test generation for combinational circuits
- 4. Use control logic for DFT
- 5. Implement BIST architectures

UNIT - I

Fault Tolerant Design: Basic Concepts: Reliability Concepts, Failure & Faults, Reliability and Failure rate, Relation between Reliability and Meantime between failure, Maintainability and Availability, Reliability of series, parallel and Parallel – Series combinational circuits.

Fault Tolerant Design: Basic Concepts – Static, dynamic, hybrid Triple Modular Redundant System, Self-purging redundancy, Siftout redundancy (SMR), 5 MR Re-Configuration techniques, Time redundancy and software redundancy.

UNIT - II

Self-Checking Circuits & Fail-Safe Design: Self Checking circuits: Basic concepts of self-checking circuits, Design of Totally self-checking checker, checkers using m out of n codes, Berger code, Low Cost residue code. Fail Safe Design: Strongly fault secure circuits, fail safe design of sequential circuits using partition theory and Berger code, totally self-checking PLA Design.

UNIT – III

ATPG Fundamentals and Design for Testability for Combinational Circuit: Introduction to ATG, ATG for SSFs in combinational circuits- basic algorithms, D and 9V algorithms, ATG for SSFs in sequential circuits using iterative array model

UNIT - IV

Design for testability: Design for Testability for Combinational logic Circuits: Basic concepts of Testability, Controllability and Observability, The Reed Muller's expansion technique, OR-AND-OR Design, Use of control logic and Syndrome Testable Designs

UNIT - V

Built In Self-Test (BIST): BIST concepts, Tests Pattern generation for BIST exhaustive testing, pseudorandom testing, pseudo exhaustive testing, constant weight patterns, Generic offline BIST architecture, Memory Test architecture.

- 1 Parag K. Lala, "Fault Tolerant & Fault Testable Hardware Design", PHI, 1984.
- Miron Abramovici, Melvin A. Breuer and Arthur D. Friedman, "Digital Systems Testing and Testable Design", Jaico Books
- Alfred L. Crouch, "Design for Test for Digital IC's and Embedded Core Systems", Pearson Education, 2008.
- 4 Bushnell & Vishwani D.Agarwal, "Essentials of Electronic Testing", Springers.

ADVANCED COMMUNICATION AND COMPUTERNETWORKS (PROGRAM SPECIFIC ELECTIVE – III)

*Instruction: 3 periods per week*Duration of SEE: 3 hours

CIE: 30 marks SEE: 70 marks

Credits: 3

Objectives:

- Overview of communication computer networks, internet, and foundation of basic networking protocols and detailed study of Data link layer and local area networks
- Study of Routing and Congestion control at the network layer.
- Learn Protocols in Network layer and multicast routing in internetworking and also, analyse of protocols Transport layer, and Application Layer.

Outcomes: At the end of this course, students will be able to:

- 1. Understand advanced concepts in Communication Networking.
- 2. Design and develop protocols for Communication Networks.
- 3. Understand the mechanisms in Quality of Service in networking.
- 4. Optimise the Network Design.
- 5. Analyse protocols multicast routing in internetworking.

UNIT – I

Data Communications concepts: Data Communications Model Communication Tasks, Networks and Networking configurations and Internet.

Foundation of Networking Protocols: 5-layer TCP/IP Model, 7-Layer OSI Model, Internet Protocols and Addressing.

UNIT - II

Data Link Control protocol: Flow Control, Sliding Window Flow Control, Error control, CRC, ARQ Protocols, Data Link Control, Bit stuffing, HDLC Operation.

Local Area Networks: LAN Architecture. Topologies, Choice of Topology, Ring and Star Usage, MAC and LLC, Generic MAC Frame Format, Multiple Access Protocols, LAN Addresses and ARP, Ethernet, Hubs, Bridges and Switches.

UNIT - III

Switching and multiplexing: Circuit Switching networks and Packet Switching: Packet Switching Principles, Datagram and Virtual Circuit switching,

Wide Area Routing: Path Selection Algorithms - Dijkstra's Algorithm, Bellman-Ford Algorithm, Packet Flooding and Deflection Routing Algorithm. Congestion Control at the Network Layer.

UNIT - IV

Networklayer: InternetProtocol: Internetworking, IPv4, IPv6Transitionfrom IPv4to IPv6

Multi cast Routing and Protocols: Basic Definitions and Techniques, Internet Group

Management Protocol (IGMP).

UNIT - V

Transport and End-to-End Protocols: User Data gram Protocol (UDP), Transmission Control Protocol (TCP), TCP Congestion Control.

Application Layer: The Web and HTTP, File Transfer: FTP, Electronic Mail in the Internet, Domain Name System (DNS).

- William Stallings, "*Data and Computer Communications*", Eigth Edition, Pearson Prentice Hall, 2007.
- Behrouz A. Forouzan, "Data Communications and Networking", Fourth Edition, Tata Mc Graw Hill, 2007.
- 3 Douglas E. Comer, "Internetworking with TCP/IP", Pearson Education, 6th Edition.
- 4 Prakash and C.gupta "*Data communications and computer networks*" second Edition, Pearson, PHI learning, 2014.

INTERNET OF THINGS (PROGRAM SPECIFIC ELECTIVE – III)

Instruction: 3 periods per week Duration of SEE: 3 hours

CIE: 30 marks SEE: 70 marks

Credits: 3

Objectives:

• To understand Smart Objects and IoT Architectures and learn about various IOT-related protocols

- To build simple IoT Systems using Arduino and Raspberry Pi
- To understand data analytics, cloud in the context of IoT and to develop IoT infrastructure for popular applications

Outcomes: At the end of this course, students will be able to:

- 1. Understand the concepts of Internet of Things
- 2. Analyze basic protocols in wireless sensor network
- 3. Design IoT applications in different domain
- 4. Able to analyze design performance
- 5. Implement basic IoT applications on embedded platform

UNIT – I

Fundamentals of IoT: Evolution of Internet of Things - Enabling Technologies - IoT Architectures: oneM2M, IoT World Forum (IoTWF) and Alternative IoT models - Simplified IoT Architecture and Core IoT Functional Stack -- Fog, Edge and Cloud in IoT - Functional blocks of an IoT ecosystem - Sensors, Actuators, Smart Objects and Connecting Smart Objects.

UNIT - II

IoT Protocols IoT access technologies: Physical and MAC layers, topology and Security of IEEE 802.15.4, 802.15.4g, 802.15.4e, 1901.2a, 802.11ah and LoRaWAN – Network Layer: IP versions, Constrained Nodes and Constrained Networks – Optimizing IP for IoT: From 6LoWPAN to 6Lo, Routing over Low Power and Lossy Networks – Application Transport Methods: Supervisory Control and Data Acquisition – Application Layer Protocols: CoAP and MQTT.

UNIT - III

Design and development design methodology: Embedded computing logic - Microcontroller, System on Chips - IoT system building blocks - Arduino - Board details, IDE programming - Raspberry Pi - Interfaces and Raspberry Pi with Python Programming.

UNIT - IV

Data analytics and supporting services: Structured Vs Unstructured Data and Data in Motion Vs Data in Rest – Role of Machine Learning – No SQL Databases – Hadoop Ecosystem – Apache Kafka, Apache Spark – Edge Streaming Analytics and Network

Analytics – Xively Cloud for IoT, Python Web Application Framework – Django – AWS for IoT – System Management with NETCONF-YANG Developing.

UNIT - V

Case studies/industrial applications: Manufacturing - Converged Plantwide Ethernet Model (CPwE) - Power Utility Industry - GridBlocks Reference Model - Smart and Connected Cities: Layered architecture, Smart Lighting, Smart Parking Architecture and Smart Traffic Control.

- David Hanes, Gonzalo Salgueiro, Patrick Grossetete, Rob Barton and Jerome Henry, "IoT Fundamentals: Networking Technologies, Protocols and Use Cases for Internet of Things", Cisco Press, 2017
- Vijay Madisetti, Arshdeep Bahga, "Internet of Things: A Hands-On Approach"

DIGITAL DESIGN AND PLDS (PROGRAM SPECIFIC ELECTIVE – IV)

Instruction: 3 periods per week Duration of SEE: 3 hours

CIE: 30 marks SEE: 70 marks

Credits: 3

Objectives:

• To simplify the multiple output functions and design of PLDs

- To know the analysis and synthesis of Synchronous and Asynchronous sequential machines
- To understand the Algorithmic State Machine chart for digital designs and minimize the state machines using merger diagrams

Outcomes: At the end of this course, students will be able to:

- 1. Minimize of multiple output functions and design using PLDs
- 2. Analyze and synthesis of Synchronous sequential machines
- 3. Analyze and synthesis of Asynchronous sequential machines
- 4. Draw Algorithmic State Machine chart for digital circuits
- 5. Simplify the states using state reduction techniques and merger diagrams

UNIT - I

Tabulation and K-Map minimization method to simplify the multi outputs. Algebraic methods for Determining Prime implicants, Essential implicants. Top- down Modular Combination Logic Design, Computer-aided design of Logic circuits. Combinational circuit Design with Programmable logic Devices (PLDs).

UNIT - II

Introduction to sequential circuits, Sequential circuit model & classification state table and state diagram. Memory devices: Latches and Flip-Flops, excitation table, characteristic equations, conversion of flip-flops and state diagram. Sequential circuits: Mealy and Moore models.

UNIT - III

Analysis and Synthesis of Synchronous sequential circuits. Synchronous Sequential Circuit Models. Sequential Circuit Analysis. One hot finite state machine design method. Finite State controllers. Algorithmic State Machine (ASM) diagram.

UNIT – IV

Analysis and Synthesis of Asynchronous sequential circuits: Analysis of Pulse mode and fundamental mode circuits. Synthesis of Pulse mode circuits. Introduction to Races, Cycles and Hazards.

UNIT – V

Simplification of Sequential circuits. Redundant states, State reduction in completely and incompletely specified circuits. Compatible and Incompatible states. Merger diagrams, optimal state assignment methods.

- 1 CD Victor, P. Nelson, H Troy Nagle, Bill D. Carrol and J David Irwin. "Digital Logic Circuit Analysis and Design", PHI, 1996.
- 2 ZviKohavi, "Switching and Finite Automata Theory", TMH, 2001.
- Parag K. Lala, "Digital System Design using Programmable Logic Devices", 2003, BSP

LOW POWER VLSI DESIGN (PROGRAM SPECIFIC ELECTIVE – IV)

Instruction: 3 periods per week Duration of SEE: 3 hours

CIE: 30 marks SEE: 70 marks

Credits: 3

Objectives:

• To study the sources of power dissipation and low power design techniques with voltage scaling and capacitance minimization approaches

- To study various low power arithmetic units and the design of low power multipliers
- To study To study about low power memory technologies

Outcomes: At the end of this course, students will be able to:

- 1. Understand various power components
- 2. Understand and design low power memories
- 3. Understand and use mathematical models for power analysis in CMOS circuits
- 4. Design low power architectures
- 5. Understand and design multipliers

UNIT – I

Fundamentals: Need for Low Power Circuit Design, Sources of Power Dissipation – Switching Power Dissipation, Short Circuit Power Dissipation, Leakage Power Dissipation, Glitching Power Dissipation, Short Channel Effects – Drain Induced Barrier Lowering and Punch Through, Surface Scattering, Velocity Saturation, Impact Ionization, Hot Electron Effect.

UNIT - II

Low-Power Design Approaches: Low-Power Design through Voltage Scaling – VTCMOS circuits, MTCMOS circuits, Architectural Level Approach – Pipelining and Parallel Processing Approaches. Switched Capacitance Minimization Approaches: System Level Measures and Circuit Level Measures.

UNIT - III

Low-VoltageLow-Power Adders: Introduction, Standard Adder Cells, CMOS Adder Architectures – Ripple Carry Adders, Carry Look-Ahead Adders, Carry Select Adders, Carry Save Adders, Low-Voltage Low-Power Design Techniques—Trends of Technology and Power Supply Voltage, Low-Voltage Low-Power Logic Styles

UNIT - IV

Low-Voltage Low-Power Multipliers: Introduction, Overview of Multiplication, Types of Multiplier Architectures, Braun Multiplier, Baugh-Wooley Multiplier, Booth Multiplier and Introduction to Wallace Tree Multiplier.

UNIT – V

Low-Voltage Low-Power Memories: Basics of ROM, Low-Power ROM Technology, Future Trend and Development of ROMs, Basics of SRAM, Memory Cell, Pre-charge and Equalization Circuit, Low-Power SRAM Technologies, Basics of DRAM, Self-Refresh Circuit, Future Trend and Development of DRAM.

- Sung-Mo Kang, Yusuf Leblebici, "CMOS Digital Integrated Circuits Analysis and Design", TMH, 2011.
- 2 Ming-BO Lin, "Introduction to VLSI Systems: A Logic, Circuit and System Perspective", CRC Press, 2011
- 3 Anantha Chandrakasan, "Low Power CMOS Design", IEEE Press/Wiley International, 1998
- 4 Kaushik Roy, Sharat C. Prasad, "Low Power CMOS VLSI Circuit Design", John Wiley & Sons, 2000.
- 5 Gary K. Yeap, "Practical Low Power Digital VLSI Design", Kluwer Academic Press, 2002.

AC 035

STRESS MANAGEMENT BY YOGA (AUDIT COURSE –II)

*Instruction: 2 periods per week*Duration of SEE: 3 hours

CIE: 30 marks SEE: 70 marks

Credits: 00

Objectives:

• To achieve overall health of body and mind.

• To overcome stress.

Outcomes: At the end of this course, students will be able to:

- 1. Develop healthy mind in a healthy body thus improving social health also
- 2. *Improve efficiency*.

UNIT – I

Introduction: Definition of **Stress** – Types of stress: Acute and chronic - Stressors – Definition of **Yoga** from various sources – Types of yoga – Karma yoga, Gnana yoga, Bhakti yoga and Raja yoga – Concept of Bhagavad Geeta - Yoga versus exercise –Basics of Physiology and Psycholoy – Brain and its parts – CNS and PNS – HPA axis – Sympethetic and Para sympethetic nervous systems – Fight and Flight mechanism - Relationship between stress and yoga.

UNIT - II

Ashtanga Yoga: Do's and Don'ts in life: i) Yam - Ahinsa, satya, astheya, bramhacharya and aparigraha ii) Niyam -Shaucha, santosh, tapa, swadhyay, ishwarpranidhan -iii) Asana iv) Pranayama v) Prathyahara vi) Dharana vii) Dhyana viii) Samadhi - Illustrations of eight steps of Ashtanga yoga.

UNIT – III

Asana and Stress:Definition of Asana from Pathanjali – Origin of various names of asanas - Various yog poses and their benefits for mind & body – Sequence of performing asanas: Standing, sitting, lying down on stomach, lying down on back and inverted postures – Activation of Annamaya kosha – Effect on various chakras, systems and glands thereby controlling the stress levels through the practice of asanas.

UNIT – IV

Pranayama and Stress: Definition of pranayama from Shankaracharya - Regularization of breathing techniques and its effects - Types of pranayama - Heat generating and cold generating techniques - Pranayama versus chakras and systems - Breathing techniques versus seasons - Anger and breathing rate - Activation of pranamaya kosha - Pranayama as the bridge between mind and body - Stress control through pranayama.

UNIT - V

Dhyana and Stress: Distinction between Dhyana and Dharana– Preparation for Dhyana through prathyahara and dharana – Activation of Vignanamaya kosha – Types of mind: conscious, superconscious and subconscious – Activation of manomaya kosha through Dhyana – Silencing the mind thereby controlling the stress levels

- 1 *'Yogic Asanas for Group Tarining-Part-I'*': Janardan Swami Yogabhyasi Mandal, Nagpur
- 2 *"Rajayoga or conquering the Internal Nature"* by Swami Vivekananda, Advaita Ashrama (Publication Department), Kolkata
- 3 Light on yoga by BKS Iyengar
- 4 "The search for happiness and bliss" by Swami Sarvapriyananda on you tube https://youtu.be/xfywJTPkw7Y
- 5 "*Mastering the mind*" by Swamini Vimalananda on you tube https://youtu.be/EXniWH9DMF8

AC 036

PERSONALITY DEVELOPMENT THROUGH LIFE ENLIGHTENMENT SKILLS (AUDIT COURSE –II)

Instruction: 2 periods per week Duration of SEE: 3 hours

CIE: 30 marks SEE: 70 marks

Credits: 00

Objectives:

• To learn to achieve the highest goal happily

- To become a person with stable mind, pleasing personality and determination
- To awaken wisdom in students

Outcomes: At the end of this course, students will be able to:

- 1. Study of Shrimad-Bhagwad-Geeta will help the student in developing his personality and achieve the highest goal in life.
- 2. The person who has studied Geeta will lead the nation and mankind to peace and prosperity
- 3. Study of Neetishatakam will help in developing versatile personality of students.

UNIT - I

Neetisatakam-Holistic development of personality

- Verses- 19,20,21,22 (wisdom)
- Verses- 29,31,32 (pride & heroism)
- Verses- 26,28,63,65 (virtue)
- Verses- 52,53,59 (dont's)
- Verses- 71,73,75,78 (do's)

UNIT - II

- Approach to day to day work and duties.
- Shrimad Bhagwad Geeta: Chapter 2-Verses 41, 47,48,
- Chapter 3-Verses 13, 21, 27, 35, Chapter 6-Verses 5,13,17, 23, 35,
- Chapter 18-Verses 45, 46, 48.

UNIT - III

- Statements of basic knowledge.
- Shrimad Bhagwad Geeta: Chapter2-Verses 56, 62, 68
- Chapter 12 -Verses 13, 14, 15, 16,17, 18
- Personality of Role model. Shrimad Bhagwad Geeta: Chapter2-Verses 17, Chapter 3-Verses 36,37,42,
- Chapter 4-Verses 18, 38,39
- Chapter 18 Verses 37,38,63

- 1 Swami Swarupananda Advaita Ashram "Srimad Bhagavad Gita", (Publication Department), Kolkata
- 2 P.Gopinath, "Bhartrihari's Three Satakam (Niti-sringar-vairagya)", Rashtriya Sanskrit Sansthanam, New Delhi

AC 037

CONSTITUTION OF INDIA (AUDIT COURSE –II)

*Instruction: 2 periods per week*Duration of SEE: 3 hours

CIE: 30 marks SEE: 70 marks

Credits: 00

Objectives:

• Understand the premises informing the twin themes of liberty and freedom from a civil rights perspective

- To address the growth of Indian opinion regarding modern Indian intellectuals' constitutional role and entitlement to civil and economic rights as well as the emergence of nationhood in the early years of Indian nationalism.
- To address the role of socialism in India after the commencement of the Bolshevik Revolution in 1917 and its impact on the initial drafting of the Indian Constitution.

Outcomes: At the end of this course, students will be able to:

- 1. Discuss the growth of the demand for civil rights in India for the bulk of Indians before the arrival of Gandhi in Indian politics.
- 2. Discuss the intellectual origins of the framework of argument that informed the conceptualization of social reforms leading to revolution in India
- 3. Discuss the circumstances surrounding the foundation of the Congress Socialist Party [CSP] under the leadership of Jawaharlal Nehru and the eventual failure of the proposal of direct elections through adult suffrage in the Indian Constitution.
- 4. Discuss the passage of the Hindu Code Bill of 1956.

UNIT - I

History of Making of the Indian Constitution: History, Drafting Committee, (Composition & Working)

UNIT – II

Philosophy of the Indian Constitution: Preamble and Salient Features

UNIT – III

- Contours of Constitutional Rights & Duties:
- Fundamental Rights
- Right to Equality
- Right to Freedom
- Right against Exploitation
- Right to Freedom of Religion
- Cultural and Educational Rights
- Right to Constitutional Remedies
- Directive Principles of State Policy
- Fundamental Duties.

UNIT - IV

- Organs of Governance:
- Parliament
- Composition
- Qualifications and Disqualifications
- Powers and Functions
- Executive
- President
- Governor
- Council of Ministers
- Judiciary, Appointment and Transfer of Judges, Qualifications
- Powers and Functions

UNIT - V

- Local Administration:
- District's Administration head: Role and Importance,
- Municipalities: Introduction, Mayor and role of Elected Representative, CE of Municipal Corporation.
- Pachayati raj: Introduction, PRI: ZilaPachayat.
- Elected officials and their roles, CEO ZilaPachayat: Position and role.
- Block level: Organizational Hierarchy (Different departments),
- Village level: Role of Elected and Appointed officials,
- Importance of grass root democracy

UNIT-VI

- Election Commission:
- Election Commission: Role and Functioning.
- Chief Election Commissioner and Election Commissioners.
- State Election Commission: Role and Functioning.
- Institute and Bodies for the welfare of SC/ST/OBC and women.

- 1 "The Constitution of India", 1950 (Bare Act), Government Publication.
- Dr. S. N. Busi, "Dr. B. R. Ambedkar framing of Indian Constitution", 1st Edition, 2015.
- 3 M. P. Jain, "Indian Constitution Law", 7th Edn. Lexis Nexis, 2014.
- 4 D.D. Basu, "Introduction to the Constitution of India", Lexis Nexis, 2015.

AC 038

PEDAGOGY STUDIES (AUDIT COURSE –II)

Instruction: 2 periods per week Duration of SEE: 3 hours

CIE: 30 marks SEE: 70 marks

Credits: 00

Objectives:

• Review existing evidence on the review topic to inform programme design and policy making undertaken by the DfID, other agencies and researchers.

• Identify critical evidence gaps to guide the development.

Outcomes: At the end of this course, students will be able to:

- 1. What pedagogical practices are being used by teachers in formal and informal classrooms in developing countries?
- 2. What is the evidence on the effectiveness of these pedagogical practices, in what conditions, and with what population of learners?
- 3. How can teacher education (curriculum and practicum) and the school curriculum and guidance materials best support effective pedagogy?

UNIT - I

Introduction and Methodology: Aims and rationale, Policy background, Conceptual framework and terminology - Theories of learning, Curriculum, Teacher education - Conceptual framework, Research questions, Overview of methodology and Searching.

UNIT - II

Thematic Overview: Pedagogical practices followed by teachers in formal and informal classrooms in developing countries - Curriculum, Teacher education.

UNIT - III

Evidence on the Effectiveness of Pedagogical Practices: Methodology for the in depth stage: quality assessment of included studies - How can teacher education (curriculum and Practicum) and the school curriculum and guidance material best support effective pedagogy? - Theory of change - Strength and nature of the body of evidence for effective pedagogical practices - Pedagogic theory and pedagogical approaches — Teachers attitudes and beliefs and pedagogic strategies.

UNIT - IV

Professional Development: Alignment with classroom practices and follow up support - Support from the head teacher and the community – Curriculum and assessment - Barriers to learning: Limited resources and large class sizes.

UNIT - V

Research Gaps and Future Directions: Research design – Contexts – Pedagogy - Teacher education - Curriculum and assessment – Dissemination and research impact.

- 1 Ackers J, Hardman F, "Classroom Interaction in Kenyan Primary Schools, Compare", 31 (2): 245 261, 2001.
- 2 Agarwal M, "Curricular Reform in Schools: The importance of evaluation", Journal of Curriculum Studies, 36 (3): 361 379, 2004.
- 3 Akyeampong K, "Teacher Training in Ghana does it count? Multisite teacher education research project (MUSTER)", Country Report 1. London: DFID, 2003.
- 4 Akyeampong K, Lussier K, Pryor J, Westbrook J, "Improving teaching and learning of Basic Maths and Reading in Africa: Does teacher Preparation count?" International Journal Educational Development, 33 (3): 272-282, 2013.
- 5 Alexander R J, "Culture and Pedagogy: International Comparisons in Primary Education", Oxford and Boston: Blackwell, 2001.
- 6 Chavan M, Read India: "A mass scale, rapid, learning to read campaign", 2003
- 7 www.pratham.org/images/resource%20working%20paper%202.pdf.

EC152

DIGITAL SYSTEM LABORATORY - II

Instruction: 3 periods per week
CIE: 50 marks
Duration of SEE: -SEE: --

Credits: 1.5

Objectives:

• To Develop Structural, Dataflow and Behavioral Modeling of Verilog HDL.

- To Know Basics of System Verilog, Randomization, test Coverage and Familiarize with Object Oriented Programming.
- To know about DFT testability and pattern generation

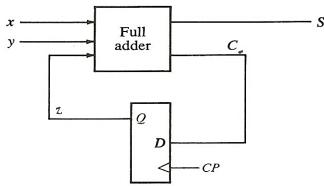
Outcomes: At the end of this course, students will be able to:

- 1. To Realize and Verify Combinational and Sequential Circuits in Verilog HDL
- 2. To Construct User Defined Data Types in System Verilog and Create Object Oriented Programming Environment
- 3. To Demonstrate Randomization, Coverage Concepts of System Verilog and Propose Efficient Testable Digital Systems in System Verilog
- 4. To design and generate simple and complex test patterns
- 5. To perform insertion testing

CYCLE -1

- 1. Implement a 4-bit pseudo-random Binary sequence generator using a linear feedback shift register with test bench?
- 2. Implement a 8-bit register with shift left and shift right modes of operation and test the logic with help of test bench?
- 3. Write Verilog program forcooking-gas delivery with following considerations (with signals request, wait, grant, fine)
 - a) Difference between two successive deliveries should be minimum of 15 days.
 - b) If user requests before 15 days, wait should be asserted
 - c) If user requests when wait is asserted, fine should be asserted
- 4. Generate Clock signal and write Verilog code for calculating frequency of clock signal?
- 5. Generate clock signal and write verilog code for skipping two clock cycles at a time and for every two clock cycles the output should be raising edge?
- 6. Prepare a LUT it contains the Train information such as train number, train time, number of sleeper classes and number of AC classes. Write a verilog code When user select the Train number the output should display the train information from the prepared LUT?
- 7. Write SV code for
 - a. Class creation Accessing class properties and methods
 - b. Class instance and object Creation d. Class Constructors
- 8. Write a SV code demonstrating access to static class properties and methods.
- 9. Write a SV code for

- a. Parent class properties accessed using child class handle.
- b. Parent class method is *overridden* in the child class.
- 10. Write a system Verilog code to show the usage of *local* keyword and *protected* keyword within and outside a class.
- 11. Write a SV codes for
 - a. Creating abstract classes
 - b. Accessing Static class member using class resolution operator
- 12. Define a base class with Half Adder as a Function.
 - a. Write the extended class for Full adder using the base class.
 - b. Write a module defining the functionality for 4 bit Ripple carry adder.
- 13. Define a parent class with a 32 bit protected parameter tmp_addr
 - 1. Write a child class containing
 - i. A constructor to initialize the parameter "tmp_addr".
 - ii. A function to increment the parameter "*tmp_addr*".
 - 2. Write a module showcasing the usage of protected variable "*tmp_addr*" after incrementing its address.
- 14. Define a base class with Full Adder as a Function.
 - a. Write the extended classes for D Flipflop.
 - b. Write a module defining the functionality for the following circuit.



- 15. Write constraint to create four random numbers a, b, c, d.
 - 1."a" should be less than 5000 and greater than 100, and should not be divisible by 2
 - 2."b" should be less than 5,000 and should be divisible by 5
 - 3."c" should be in the range of 1 to 5 and include the expression [(a-b): (a+b))]
 - 4."d" should be greater than all a, b and c.
- 16. Write a SV code for
 - a. Cover group
 - b. Cover point
 - c. cross
 - d. bin

CYCLE-2

List of assignments

- 1. Fault models and test patterns
- 2. Automatic test pattern generation

- 3. Full DFT flow and ATPG setup
- 4. Fault locations, Test patterns and pattern generation
- 5. Fault models
- 6. Design Rule checks and test coverage

DFT experiments

- 1. Basic Scan Test by Scan Flip-Flops/Scan Cells
- 2. Test Patterns and Test Patterns Generation
- 3. Scan Insertion Using Tessent Scan.
- 4. ATPG basic scan patterns Using Tessent Fast Scan.
- 5. Configuring Scan Chains.
- 6. Advanced Fault Models and Complex Pattern Generation.

EC 162

SEMINAR - II

Instruction: 3 periods per week
CIE: 50 marks

Duration of SEE: -SEE: --

Credits: 1.5

Outcomes: At the end of this course, students will be able to:

- 1. Develop the habit of referring the journals for literature review.
- 2. *Understand the gist of the research paper.*
- *3. Identify the potential for further scope.*
- 4. Present the work in an efficient manner.
- 5. Write the documentation in standard format.

Seminar topics may be chosen by the students with advice from the faculty members and the student shall read further relevant articles in the domain.

The seminar must be clearly structured and the power point presentation shall include following aspects:

- 1. Introduction to the field
- 2. Literature survey
- 3. Consolidation of available information
- 4. Summary and Conclusions
- 5. References

Each student is required to:

- 1. Deliver the seminar for a maximum duration of 30 minutes, where the presentation should be for 20 minutes in PowerPoint, followed by Question and Answers session for 10 minutes.
- 2. Submit the detailed report of the seminar in spiral bound in a précised format as suggested by the Department.

Guidelines for awarding marks				
S. No.	Description	Max. Marks		
1	Contents and relevance	10		
2	Presentation skills	10		
3	Preparation of PPT slides	05		
4	Questions and answers	05		
5	Report in a prescribed format	20		

Note:

- 5. The seminar presentation should be a gist of at least five research papers from **Peer-reviewed** or **UGC recognised** journals.
- 6. **The seminar report should be in the following order:** Background of work, literature review, techniques used, prospective deliverables, discussion on results, conclusions, critical appraisal and reference.
- 7. At least two faculty members will be associated with the seminar presentation to evaluate and award marks.
- 8. Attendance of all the students for weekly seminar presentations is compulsory. If the student fails to secure minimum attendance as per O.U. rules, the marks awarded in the seminar presentation shall remain void.

EC 070

MINI PROJECT

Instruction: 6 periods per week Duration of SEE: --

CIE: 50 marks SEE: --

Credits: 3

Outcomes: At the end of this course, students will be able to:

- 1. Formulate a specific problem and give solution
- 2. Develop model/models either theoretical/practical/numerical form
- 3. Solve, interpret/correlate the results and discussions
- 4. Conclude the results obtained
- 5. Write the documentation in standard format

Guidelines:

- As part of the curriculum in the II- semester of the programme each student shall do a mini project, generally comprising about three to four weeks of prior reading, twelve weeks of active research, and finally a presentation of their work for assessment.
- Each student will be allotted to a faculty supervisor for mentoring.
- Mini projects should present students with an accessible challenge on which to demonstrate competence in research techniques, plus the opportunity to contribute something more original.
- Mini projects shall have inter-disciplinary/industry relevance.
- The students can select a mathematical modeling based/Experimental investigations or Numerical modeling
- All the investigations should be clearly stated and documented with the reasons/explanations.
- The mini-project shall contain a clear statement of the research objectives, background of work, literature review, techniques used, prospective deliverables, and detailed discussion on results, conclusions and reference

Departmental committee: Supervisor and a minimum of two faculty members

Guidelines for awarding marks in CIE (Continuous Internal Evaluation): Max. Marks: 50				
Evaluation by	Max. Marks	Evaluation Criteria /		
Evaluation by		Parameter		
Supervisor	20	Progress and Review		
Supervisor	05	Report		
	05	Relevance of the Topic		
	05	PPT Preparation		
Departmental Committee	05	Presentation		
	05	Question and Answers		
	05	Report Preparation		

SEMESTER – III

EC 119

ANALOG AND MIXED SIGNAL IC DESIGN (PROGRAM SPECIFIC ELECTIVE – V)

Instruction: 3 periods per week Duration of SEE: 3 hours

CIE: 30 marks SEE: 70 marks

Credits: 3

Objectives:

- To Design Basic Building Blocks of Opamp: Current Mirror, Single Stage Amplifiers
- To Design and Analyze Two-Stage Opamp and familiarize with Folded Cascade Opamps
- To Know Applications of Opamps and learn Data Converters and Phased Locked Loops (PLL)

Outcomes: At the end of this course, students will be able to:

- 1. To Develop Mathematical Modeling of Building Blocks of Opamps
- 2. To Design and Simulate Two-Stage Opamp for the Given Specifications
- 3. To Analyze the Performance of Operational Trans-Conductance Amplifier.
- 4. To Develop Switched Capacitor Circuits
- 5. To Outline the Principle of Operation of Over-Sampling Rate A/D and D/A Converters

UNIT – I

Building Blocks of Opamp:

MOS Transistor – Nanometer Transistor and its model – body effect, Channel Length Modulation and short channel effects – velocity saturation, sub-threshold conduction, threshold voltage control, drain induced barrier lowering, gate induced drain leakage, Complete MOS Transistor Model and large and small signal models of BJTs and MOSFETs.

Current Mirrors and Single Stage Amplifiers – Simple CMOS current mirror, common source amplifier, source follower, common gate amplifier, cascode amplifiers. Source degenerated current mirrors, cascode current mirror, cascode gain stage and MOS differential pair and gain stage.

Biasing and References – Analog IC biasing, establishing constant trans-conductance and band-gap reference – Positive and negative temperature coefficient basics and circuits.

UNIT - II

Basic Opamp and Compensation: Basic two-stage MOS Operational amplifier, characteristic parameters, compensation, design and analysis of two-stage MOS opamp with given specifications. Stability and frequency compensation of op-amps.

UNIT - III

Operational Trans-conductance Amplifier (OTA):

Advanced current Mirrors – Wilson current mirror, Enhanced output-impedance current mirror and gain boosting and wide swing current mirror with enhanced output impedance and bipolar current mirrors – bipolar gain stages.

Single stage Opamp – Folded-cascade opamp, current mirror opamp, fully differential opamp and common mode feedback circuits.

UNIT - IV

Applications of Opamp

Comparators: Op-Amp Based Comparators, Charge Injection Errors – Latched Comparators – CMOS and BiCMOS Comparators – Bipolar Comparators.

Switched capacitor circuits: Basic building blocks; basic operation and analysis, inverting and non-inverting integrators, signal flow diagrams, first order filter.

Sample and hold circuits - Performance requirements, MOS sample and hold basics, clock feed through problems, S/H using transmission gates, high input impedance S/H circuits, improved S/H circuits from the point of slewing time, clock feed through cancellations.

UNIT - V

Mixed Signal IC Applications:

Data Converters – Review of Nyquist-Rate A/D and D/A converters, Noise Sources: Flicker, Thermal, Oversampling converters – Over sampling without noise shaping and with noise shaping, system architectures and digital decimation filters.

Phase locked loops – simple PLL, charge pump PLL and dynamics of PLL.

Practical Issues – Transistor mismatch, offset and techniques to reduce the analog non-idealities (like auto-zero, chopping, CDS etc) and Basics of Analog Layout

- Tony Chan Carusone, David Johns and Ken Martin, "Analog Integrated Circuit Design", 2nd edition, John Wiley & sons. 2013.
- 2 Behzad Razavi, "Design of Analog CMOS Integrated Circuits", McGraw Hill Companies, 2013.
- Philip E. Allen and Douglas R. Holberg, "*CMOS Analog Circuit Design*", 2nd edition, Oxford University Press, 2010.

EC 120

VLSI SIGNAL PROCESSING (PROGRAM SPECIFIC ELECTIVE – V)

*Instruction: 3 periods per week*Duration of SEE: 3 hours

CIE: 30 marks SEE: 70 marks

Credits: 3

Objectives:

• To enable the students to learn about the concept of pipelining and parallel processing in VLSIand the students to identify applications for unfolding algorithm

- To make the students to understand the analysis of VLSI system with high speed and low power and equip the students with knowledge of Systolic Design for Space Representations containing Delays
- To make the students to understand the concept of Power Reduction and Estimation techniques in VLSI signal processing

Outcomes: At the end of this course, students will be able to:

- 1. Explain parallel and pipelining processing techniques.
- 2. Identify applications for unfolding algorithm
- 3. Analyse Systolic Design for Space Representations containing Delays
- 4. Explain Cook-Toom Algorithm, Fast Convolution algorithm by Inspection method.
- 5. Analyze Power Reduction techniques and Power Estimation techniques

UNIT - I

Introduction to DSP: Typical DSP algorithms, DSP algorithms benefits, Representation of DSP algorithms. Pipelining and Parallel Processing: Introduction, Pipelining of FIR Digital filters, Parallel Processing, Pipelining and Parallel Processing for Low Power, Retiming: Introduction—Definitions and Properties—Solving System of Inequalities—Retiming Techniques

UNIT - II

Folding and Unfolding, Folding: Introduction -Folding Transform - Register minimizationTechniques - Register minimization in folded architectures - folding of multirate systems, Unfolding: Introduction - An Algorithm for Unfolding - Properties of Unfolding - criticalPath, Unfolding and Retiming - Applications of Unfolding

UNIT – III

Systolic Architecture Design: Introduction – Systolic Array Design Methodology – FIRSystolic Arrays – Selection of Scheduling Vector – Matrix Multiplication and 2D Systolic Array Design – Systolic Design for Space Representations contain Delays

UNIT - IV

Fast Convolution: Introduction – Cook-Toom Algorithm – Winogard algorithm – IteratedConvolution – Cyclic Convolution – Design of Fast Convolution algorithm by Inspection.

UNIT - V

Low Power Design: Scaling Vs Power Consumption—Power Analysis, Power Reductiontechniques — Power Estimation Approaches, Programmable DSP: Evaluation of ProgrammableDigital Signal Processors, DSP Processors for Mobile and Wireless Communications, Processors for Multimedia Signal Processing

- 1 Keshab K. Parthi, "VLSI Digital Signal Processing- System Design and Implementation", 1998, Wiley Inter Science.
- 2 Kung S. Y, H. J. While House, T. Kailath, "VLSI and Modern Signal processing", 1985, Prentice Hall.
- Jose E. France, Yannis Tsividis, "Design of Analog Digital VLSI Circuits for Telecommunications and Signal Processing", 1994, Prentice Hall.
- 4 Medisetti V. K, "VLSI Digital Signal Processing", IEEE Press (NY), USA, 1995.

EC 121

APPLICATIONS OF NANO TECHNOLOGY (PROGRAM SPECIFIC ELECTIVE – V)

Instruction: 3 periods per week Duration of SEE: 3 hours

CIE: 30 marks SEE: 70 marks

Credits: 3

Objectives:

• To learn the effect of Nano sized materials on physical properties

- To learn nanotechnology concepts with rigorous scientific understanding.
- To learn characterizing physical properties of nano materials
- To learn nano material synthesis techniques
- To learn the applications of Nanotechnology

Outcomes: At the end of this course, students will be able to:

- 1. To understand the convergence of many sciences and technologies at the nanometer scale.
- 2. To serve as a standalone comprehensive introduction to applications of nanotechnology.
- 3. To explore physical characteristics of nanomaterial's
- 4. To investigate newer synthesis techniques for nanomaterial's
- 5. To correlate physical properties and Nano sized materials

UNIT – I

Structure and Length Scales: Basic properties, Examples of Crystal structures, Miller indices, Surface-to volume ratio, introduction to Length Scales, de Broglie wavelength, The Bohr radius, Excitons, Confinement regimes, Metals, The Fermi energy, Fermi velocity, and Kubo gap, The mean free path in metals, Charging energy.

UNIT - II

Types of Nanostructures and Absorption and Emission Basics: Introduction to Types of Nanostructures, Bottom-up or top-down, Exponential attenuation law, Relating ϵ_{molar} to σ , Estimating α and σ , using the absorption cross section, Emission processes, Einstein A and B coefficients, Relating absorption cross sections to excited-state lifetimes.

UNIT – III

A Quantum Mechanics Review: Wave functions, Observables and the correspondence principle, Eigenvalues and Eigenfunctions, Wavepackets, Expectation values, Dirac bra-ket notation, Operator math, The uncertainty Principle, The Schrodinger equation, The postulates of quantum mechanics, and Model problems for wells, wires, and dots.

UNIT - IV

Density of States, Bands and Interband Transitions: Density of states for bulk materials, wells, wires and dots, Population of the conduction and valence bands, Joint density of states, The Kronig-Penney model, Metals, semiconductors, and insulators, Bulk semiconductor, Transitions in low-dimensional semiconductors.

UNIT - V

Synthesis, Characterization and Applications: Molecular beam epitaxy (MBE), Colloidal growth of nanocrystals, Semiconductor nanocrystals, Sizing nanostructures, Optical characterization, Quantum dots, Metal nanostructures, Nanowires.

- 1 Michael F. Ashby, Paulo J. Ferreira, Daniel L. Schodek, "Nanomaterials, Nanotechnologies and Design", Elsevier BH Publications, 2011 New Delhi.
- 2 Masaru Kuno, "Introductory Nano science", Garland Science Taylor and Francis Group, 2012, London.
- Gabor L. Harnyak, John J. Moore, Harry F. Tibbals, Joydeep Dutta, "Fundamentals of Nanotechnology", CRC Press, 2008, New York
- 4 Ben Rogers, Sumitha Pennathur, Jesse Adams, "Nanotechnology, Understanding Small Systems", Second Edition CRC Press, New York, 2011.
- 5 K.K. Chattopadhyaya, A.N. Bannerjee, "Introduction to Nanoscience and Nanotechnology", PHI Learning Pvt. Ltd., New Delhi, 2012.

BUSINESS ANALYTICS (OPEN ELECTIVE)

Instruction: 3 periods per week Duration of SEE: 3 hours

CIE: 30 marks SEE: 70 marks

Credits: 3

Objectives:

• *Understanding the basic concepts of business analytics and applications*

- Study various business analytics methods including predictive, prescriptive and prescriptive analytics
- Prepare the students to model business data using various data mining, decision making methods

Outcomes: At the end of this course, students will be able to:

- 1. To understand the basic concepts of business analytics
- 2. Identify the application of business analytics and use tools to analyze business data
- 3. Become familiar with various metrics, measures used in business analytics
- 4. Illustrate various descriptive, predictive and prescriptive methods and techniques
- 5. Model the business data using various business analytical methods and techniques

UNIT – I

Introduction to Business Analytics: Introduction to Business Analytics, needand science of data driven (DD) decision making, Descriptive, predictive, prescriptive analytics and techniques, Big data analytics, Web and Social media analytics, Machine Learning algorithms, framework for decision making, challenges in DD decision making and future.

UNIT – II

Descriptive Analytics: Introduction, data types and scales, types of measurementscales, population and samples, measures of central tendency, percentile, decile and quadrille, measures of variation, measures of shape-skewness, data visualization

UNIT – III

Forecasting Techniques: Introduction, time-series data and components, forecasting accuracy, moving average method, single exponential smoothing, Holt's method, Holt-Winter model, Croston's forecasting method, regression model for forecasting, Auto regression models, auto-regressive moving process, ARIMA, Theil's coefficient

UNIT - IV

Decision Trees: CHAID, Classification and Regression tree, splitting criteria, Ensemble and method and random forest. Clustering: Distance and similarity measures used in clustering, Clustering algorithms, K-Means and Hierarchical algorithms, Prescriptive Analytics - Linear Programming(LP) and LP model building,

UNIT - V

Six Sigma: Introduction, introduction, origin, 3-Sigma Vs Six-Sigma process, cost of poor quality, sigma score, industry applications, six sigma measures, DPMO, yield, sigma score, DMAIC methodology, Six Sigma toolbox

- U Dinesh Kumar, "*Data Analytics*", Wiley Publications, 1st Edition, 2017. Marc J. Schniederjans, Dara G. Schniederjans, Christopher M. Starkey, "*Business*"
- 2 analytics Principles, Concepts, and Applications with SAS", Associate Publishers, 2015.
- S. Christian Albright, Wayne L. Winston, "Business Analytics Data Analysis and Decision Making", 5th Edition, Cengage, 2015.
- 4 https://onlinecourses.nptel.ac.in/noc18-mg11/preview
- 5 https://nptel.ac.in/courses/110105089/

INDUSTRIAL SAFETY (OPEN ELECTIVE)

Instruction: 3 periods per week Duration of SEE: 3 hours

CIE: 30 marks SEE: 70 marks

Credits: 3

Course Objectives:

• Causes for industrial accidents and preventive steps to be taken.

- Fundamental concepts of Maintenance Engineering.
- About wear and corrosion along with preventive steps to be taken
- *The basic concepts and importance of fault tracing.*
- The steps involved in carrying out periodic and preventive maintenance of various equipments used in industry

Course Outcomes:

- 1. Identify the causes for industrial accidents and suggest preventive measures.
- 2. *Identify the basic tools and requirements of different maintenance procedures.*
- 3. Apply different techniques to reduce and prevent Wear and corrosion in Industry.
- 4. Identify different types of faults present in various equipments like machine tools, IC Engines, boilers etc.
- 5. Apply periodic and preventive maintenance techniques as required for industrial equipments like motors, pumps and air compressors and machine tools etc

UNIT-I

Industrial safety: Accident, causes, types, results and control, mechanical and electrical hazards, types, causes and preventive steps/procedure, describe salient points of factories act 1948 for health and safety, wash rooms, drinking water layouts, light, cleanliness, fire, guarding, pressure vessels, etc, Safety color codes, Fire prevention and firefighting, equipment and methods.

UNIT-II

Fundamentals of Maintenance Engineering: Definition and aim of maintenance engineering, Primary and secondary functions and responsibility of maintenance department, Types of maintenance, Types and applications of tools used for maintenance, Maintenance cost & its relation with replacement economy, Service life of equipment.

UNIT-III

Wear and Corrosion and their Prevention: Wear- types, causes, effects, wear reduction methods, lubricants-types and applications, Lubrication methods, general sketch, working and applications of Screw down grease cup, Pressure grease gun, Splash lubrication, Gravity lubrication, Wick feed lubrication, Side feed lubrication, Ring lubrication, Definition of corrosion, principle and factors affecting the corrosion, Types of corrosion, corrosion prevention methods.

UNIT-IV

Fault Tracing: Fault tracing-concept and importance, decision tree concept, need and applications, sequence of fault finding activities, show as decision tree, draw decision tree for problems in machine tools, hydraulic, pneumatic, automotive, thermal and electrical equipment's like, any one machine tool, Pump, Air compressor, Internal combustion engine, Boiler, Electrical motors, Types of faults in machine tools and their general causes.

UNIT-V

Periodic and Preventive Maintenance: Periodic inspection-concept and need, degreasing, cleaning and repairing schemes, overhauling of mechanical components, overhauling of electrical motor, common troubles and remedies of electric motor, repair complexities and its use, definition, need, steps and advantages of preventive maintenance. Steps/procedure for periodic and preventive maintenance of Machine tools, Pumps, Air compressors, Diesel generating (DG) sets, Program and schedule of preventive maintenance of mechanical and electrical equipment, advantages of preventive maintenance. Repair cycle concept and importance

Suggested Reading:

- 1. H. P. Garg, "Maintenance Engineering", S. Chand and Company
- 2. Audels, "Pump-hydraulic Compressors", Mcgraw Hill Publication
- 3. Higgins & Morrow, "Maintenance Engineering Handbook", Da Information Services.
- 4. Winterkorn, Hans, "Foundation Engineering Handbook", Chapman & Hall London

OPERATION RESEARCH (OPEN ELECTIVE)

Instruction: 3 periods per week Duration of SEE: 3 hours

CIE: 30 marks SEE: 70 marks

Credits: 3

Objectives:

• Introduce the concepts of optimization techniques

- Formulation of LPP models
- Basic concepts of Non-linear programming, Dynamic programming, Game theory are introduced.

Outcomes:

- 1. Students should able to apply the dynamic programming to solve problems of discreet and continuous variables.
- 2. Students should able to apply the concept of non-linear programming
- 3. Students should able to carry out sensitivity analysis
- 4. Student should able to model the real world problem and simulate it.
- 5. Student should able to apply graph theory, competitive models, and game theory simulations.

UNIT I

Optimization Techniques, Model Formulation, models, General L.R Formulation, Simplex Techniques, Sensitivity Analysis, Inventory Control Models

UNIT II

Formulation of a LPP - Graphical solution revised simplex method - duality theory - dual simplex method - sensitivity analysis - parametric programming

UNIT III:

Nonlinear programming problem - Kuhn-Tucker conditions min cost flow problem - max flow problem - CPM/PERT

UNIT IV

Scheduling and sequencing - single server and multiple server models deterministic inventory models - Probabilistic inventory control models - Geometric Programming.

UNIT V

Competitive Models, Single and Multi-channel Problems, Sequencing Models, Dynamic Programming, Flow in Networks, Elementary Graph Theory, Game Theory Simulation

Suggested Reading::

- 1. H.A. Taha, Operations Research, An Introduction, PHI, 2008
- 2. H.M. Wagner, Principles of Operations Research, PHI, Delhi, 1982.
- 3. J.C. Pant, Introduction to Optimisation: Operations Research, Jain Brothers, Delhi, 2008
- 4. Hitler Libermann Operations Research: McGraw Hill Pub. 2009
- 5. Pannerselvam, Operations Research: Prentice Hall of India 2010
- 6. Harvey M Wagner, Principles of Operations Research: Prentice Hall of India 2010.

COST MANAGEMENT OF ENGINEERING PROJECTS (OPEN ELECTIVE)

Instruction: 3 periods per week
CIE: 30 marks

Duration of SEE: 3 hours
SEE: 70 marks

Credits: 3

Course Objectives:

- Introduce the concepts of cost management, inventory valuation, decision making
- Fundamentals of cost overruns, project execution and technical activities
- Introduce the concepts of Quantitative techniques for cost management, Linear Programming, PERT/CPM

Course Outcomes:

- 1. Understanding of strategic cost management process, control of cost and decision making based on the cost of the project.
- 2. Ability to appreciative detailed engineering activities of the project and execution of projects
- 3. Preparation of project report and network diagram
- 4. Able to plan Cost Behavior, Profit Planning, Enterprise Resource Planning, Total Quality Management.
- 5. Applications of various quantitative techniques for cost management

UNIT-I

Project Management: Introduction to project managements, stakeholders, roles, responsibilities and functional relationships. Principles of project management, objectives and project management system. Project team, organization, roles, responsibilities. Concepts of project planning, monitoring, staffing, scheduling and controlling.

UNIT-II

Project Planning and Scheduling: Introduction for project planning, definingactivities and their interdependency, time and resource estimation. Work break down structure. Linear scheduling methods-bar charts, Line of Balance (LOB), their limitations. Principles, definitions of network-based scheduling methods: CPM, PERT. Network representation, network analysis-forward and backward passes.

UNIT-III

Project Monitoring and Cost Analysis: introduction-Cost concepts in decision-making; Relevant cost, Differential cost, Incremental cost and Opportunity cost. Objectives of a Costing System; Inventory valuation; Creation of a Database for operational control; Provision of data for Decision-Making, Time cost tradeoff-Crashing project schedules, its impact on time on time, cost. Project direct and indirect costs.

UNIT-IV

Resources Management and Costing-Variance Analysis: Planning, EnterpriseResource Planning, Resource scheduling and levelling. Total Quality Management and Theory of

constraints. Activity-Based Cost Management, Bench Marking; Balanced Score Card and Value-Chain Analysis. Standard Costing and Variance Analysis. Pricing strategies: Pareto Analysis. Target costing, Life Cycle Costing. Costing of service sector. Just-in-time approach, Material Requirement

UNIT-V

Budgetary Control:: Flexible Budgets; Performance budgets; Zero-basedbudgets. Measurement of Divisional profitability pricing decisions including transfer pricing. Quantitative techniques for cost management: Linear Programming, PERT/CPM, Transportation Assignment problems, Simulation, Learning Curve Theory.

Suggested Reading:

- 1. Charles T Horngren "Cost Accounting A Managerial Emphasis", Pearson Education; 14 edition (2012),
- 2. Charles T. Horngren and George Foster, "Advanced Management Accounting" Prentice-Hall; 6th Revised edition (1 February 1987)
- 3. Robert S Kaplan Anthony A. Atkinson, "Management & Cost Accounting", Pearson; 2 edition (18 October 1996)
- 4. K. K Chitkara, "Construction Project Management: Planning, scheduling and controlling", Tata McGraw-Hill Education. (2004).
- 5. Kumar Neeraj Jha "Construction Project Management Theory and Practice", Pearson Education India; 2 edition (2015)

COMPOSITE MATERIALS (OPEN ELECTIVE)

*Instruction: 3 periods per week*Duration of SEE: 3 hours

CIE: 30 marks SEE: 70 marks

Credits: 3

Objectives:

• To understand the fundamentals of composite materials and the role of matrix and reinforcement.

- To know the principles of manufacturing composite
- To understand the strength and failure criteria of lamina and laminate.

Outcomes: At the end of this course, students will be able to:

- 1. Define a composite, identify the matrix and reinforcement and highlighting the features and application of different composite materials.
- 2. Classify composites, illustrate the mechanical behaviour of composites and predict properties using micromechanics principles.
- 3. Illustrate the manufacturing of metal matrix composites and outline the properties and applications.
- 4. Illustrate the manufacturing of Polymer matrix composites and outline the properties and applications.
- 5. Apply various failure criteria to assess the strength of lamina and laminates.

UNIT – I

Introduction: Definition- Classification and characteristics of composite materials. Advantages and applications of composites. Functional requirements of reinforcement and matrix. Effect of reinforcement (size, distribution, volume fraction) on overall composite performance.

UNIT – II

Reinforcements: Preparation-layup, curing, properties and applications of glass fibers, carbon fibers and Boron fibers. Properties and applications of whiskers, particulate reinforcements. Mechanical Behaviour of composites: Rule of Mixtures, Inverse rule of mixtures, Isostrain and Isostress condition.

UNIT - III

Manufacturing of Metal Matrix Composites: Casting-Solid State diffusion technique, Cladding-Hot Isostatic pressing, Properties and applications. Manufacturing of Ceramic Matrix Composites: Liquid Metal Infiltration-Liquid phase sintering, Manufacturing of Carbon-Carbon composites: Knitting, Braiding, Weaving, Properties and applications

UNIT - IV

Manufacturing of Polymer Matrix Composites: Preparation of Moulding compounds and prepregs-hand layup method-Autoclave method-Filament winding method-Compression moulding-Reaction injection moulding, Properties and applications.

UNIT - V

Strength: Laminar Failure Criteria-strength ratio, maximum stress criteria, maximum strain criteria, interacting failure criteria, hydrothermal failure. Laminate first ply failure-insight strength; Laminate strength-ply discount truncated maximum strain criterion; strength design using caplet plots; stress concentration.

- 1 *Material Science and Technology* Vol 13- Composites by R.W. Cahn-VCH, West Germany.
- 2 *Materials Science and Engineering, An Introduction*. WD Callister, Jr., Adapted by R. Balasubramaniam, John Wiley &Sons, NY, Indian edition, 2007.
- 3 Composite Materials- K. K. Chwala.
- 4 *Composite Materials Science and Applications*-Deborah D.L. Chung.
- 5 Composite Materials Design and Applications-Danial Gay, Suong V. Hoa and Stwphen W. Tsai.

WASTE TO ENERGY (OPEN ELECTIVE)

*Instruction: 3 periods per week*Duration of SEE: 3 hours

CIE: 30 marks SEE: 70 marks

Credits: 3

Objectives:

• To know the various forms of waste

- To understand the processes of Biomass Pyrolysis.
- To learn the technique of Biomass Combustion.

Outcomes: At the end of this course, students will be able to:

- 1. Understand the concept of conservation of waste
- 2. Identify the different forms of wastage
- 3. Choose the best way for conservation to produce energy from waste
- 4. Explore the ways and means of combustion of biomass
- 5. Develop a healthy environment for the mankind

UNIT - I

Introduction to Energy from Waste: Classification of waste as fuel – Agro based, Forest residue, Industrial waste - MSW – Conversion devices – Incinerators, gasifiers, digestors.

UNIT - II

Biomass Pyrolysis: Pyrolysis – Types, slow fast – Manufacture of charcoal –Methods - Yields and application – Manufacture of pyrolytic oils and gases, yields and applications.

UNIT - III

Biomass Gasification: Gasifiers – Fixed bed system – Downdraft and updraftgasifiers – Fluidized bed gasifiers – Design, construction and operation – Gasifier burner arrangement for thermal heating – Gasifier engine arrangement and electrical power – Equilibrium and kinetic consideration in gasifier operation.

UNIT - IV

Biomass Combustion: Biomass stoves – Improved chullahs, types, some exotic designs, fixed bed combustors, Types, inclined grate combustors, Fluidized bed combustors, Design, construction and operation - Operation of all the above biomass combustors.

UNIT - V

Biogas: Properties of biogas (Calorific value and composition) - Biogas planttechnology and status - Bio energy system - Design and constructional features - Biomass resources and their classification - Biomass conversion processes - Thermo chemical conversion - Direct combustion - biomass gasification - pyrolysis and liquefaction - biochemical conversion - anaerobic digestion - Types of biogas Plants - Applications - Alcohol production from biomass - Bio diesel production - Urban waste to energy conversion - Biomass energy programme in India.

- 1 Non Conventional Energy, Desai, Ashok V., Wiley Eastern Ltd., 1990. Biogas Technology - A Practical Hand Book - Khandelwal, K. C. and Mahdi, S. S.,
- Vol. I & II, Tata McGraw Hill Publishing Co. Ltd., 1983.
- Food, Feed and Fuel from Biomass, Challal, D. S., IBH Publishing Co. Pvt. Ltd., 1991.
- 4 Biomass Conversion and Technology, C. Y. WereKo-Brobby and E. B. Hagan, John Wiley & Sons, 1996.

INTERNET OF THINGS (Open Elective)

Instruction: 3periods per week Duration of SEE: 3

hours

CIE: 30 marks SEE: 70 marks

Credits: 3

Course Objectives:

• To understand the concepts of Internet of Things and able to build IoT applications

• To learn the programming and use of Arduino and Raspberry Pi boards.

• To know about data handling and analytics in SDN.

Course Outcomes:

After Completion of the course Student will be able to:

- 1. Known basic protocols in sensor networks.
- 2. Program and configure Arduino boards for various designs.
- 3. Python programming and interfacing for Raspberry Pi.
- 4. Design IoT applications in different domains.

UNIT - I

Introduction to Internet of Things, Characteristics of IoT, Physical design of IoT, Functional blocks of IoT, Sensing, Actuation, Basics of Networking, Communication Protocols, Sensor Networks.

UNIT - II

Machine-to-Machine Communications, Difference between IoT and M2M, Interoperability in IoT, Introduction to Arduino Programming, Integration of Sensors and Actuators with Arduino,

UNIT - III

Introduction to Python programming, Introduction to Raspberry Pi, Interfacing Raspberry Pi with basic peripherals, Implementation of IoT with Raspberry Pi

UNIT - IV

Implementation of IoT with Raspberry Pi, Introduction to Software defined Network (SDN), SDN for IoT, Data Handling and Analytics,

UNIT - V

Cloud Computing, Sensor-Cloud, Smart Cities and Smart Homes, Connected Vehicles, Smart Grid, Industrial IoT, Case Study: Agriculture, Healthcare, Activity Monitoring

Suggested Readings:

- 1. "The Internet 'of Things: Enabling Technologies, Platforms, and Use Cases", by PethuruRaj and Anupama C. Raman (CRC Press).
- 2. "Make sensors": Terokarvinen, kemo, karvinen and villeyvaltokari, 1st edition, maker media, 2014.
- 3. "Internet of Things: A Hands-on Approach", by ArshdeepBahga and Vijay Madisetti Vijay Madisetti,
- 4. ArshdeepBahga, "Internet of Things: A Hands-On Approach"
- 5. WaltenegusDargie,ChristianPoellabauer, "Fundamentals of Wireless Sensor Networks: Theory and Practice"
- 6. Beginning Sensor networks with Arduino and Raspberry Pi Charles Bell, Apress, 2013

CYBER SECURITY

(Open Elective)

Instruction: 3periods per week Duration of SEE: 3 hours

CIE: 30 marks SEE: 70 marks

Credits: 3

Course Objectives

• Learn the various threats in networks and security concepts.

- Apply authentication applications in different networks.
- Understand security services for email.
- Awareness of firewall and IT laws and policies

Course Outcomes:

After completion of this course, the students shall be able to:

- 1. Understand the various network threats.
- 2. Analyze the forensic tools for evidence collection.
- 3. Apply the firewalls for threat analysis.

UNIT-I

Ethical hacking, Attack Vectors, Cyberspace and Criminal Behaviour, Clarification of Terms, Traditional Problems associated with Computer Crimes, Realms of Cyber world, brief history of the internet, contaminants and destruction of data, unauthorized access, computer intrusions, white-collar crimes, viruses and malicious code, virus attacks, pornography, software piracy, mail bombs, exploitation, stalking and obscenity in internet, Cyber psychology, Social Engineering.

UNIT-II

Introduction to Digital forensics, Forensic software and handling, forensic hardware and handling, analysis and advanced tools, forensic technology and practices, Biometrics: face, iris and fingerprint recognition, Audio-video evidence collection, Preservation and Forensic Analysis.

UNIT-III

Investigation Tools, e-discovery, EDRM Models, digital evidence collection and preservation, email investigation, email tracking, IP tracking, email recovery, searc and seizure of computer systems, password cracking.

UNIT-IV

Forensic Analysis of OS artifact, Internet Artifacts, File System Artifacts, Registry Artifacts, Application Artifacts, Report Writing, Mobile Forensic- identification, collection and preservation of mobile evidences, social media analysis, data retrival, Email analysis from mobile phones.

UNIT-V

Ethics, Policies and IT Act Basics of Law and Technology, Introduction to Indian Laws, Scope and Jurisprudence, Digital Signatures, E Commerce-an Introduction, possible crime scenarios, law coverage, data interchange, mobile communication development, smart card and expert systems Indian Laws, Information Technology Act 2000, Indian Evidence Act, India Technology Amendment Act 2008, Indian Penal Code, Computer Security Act 1987, National Information Infrastructure Protection Act 1996, Fraud Act 1997, Children Online Protection Act 1998, Computer Fraud and Abuse Act 2001, Intellectual Property, IP Theft, Copyright, Trademark, Privacy and Censorship, Introduction to Cyber Ethics, rights over intellectual property, Corporate IT Policy Formulations, Compliance Auditing.

Suggested Readings

- 1. Charles P. Fleeger, "Security in Computing", Prentice Hall, New Delhi, 2009.
- 2. Behrouz A. Forouzan, "Cryptography & Network Security", Tata McGraw Hill, India, New Delhi, 2009.
- 3. William Stallings, "Cryptography and Network Security", Prentice Hall, New Delhi, 2006.
- 4. Chalie Kaufman, Radia Perlman, Mike Speciner, "Network Security: Private Communication in a Public Network", Pearson Education, New Delhi, 2004.
- 5. Neal Krawetz, "Introduction to Network Security", Thomson Learning, Boston, 2007.
- 6. Bruce Schneier, "Applied Cryptography", John Wiley & Sons, New York, 2004.

EC 181

MAJOR PROJECT PHASE - I

Instruction: 20 periods per week Duration of SEE: --

CIE: 100 marks SEE: --

Credits: 10

Outcomes: At the end of this course, students will be able to:

1. Exposed to self-learning various topics.

- 2. Learn to survey the literature such as books, journals and contact resource persons for the selected topic of research.
- 3. Learn to write technical reports.
- 4. Develop oral and written communication skills to present.
- 5. Defend their work in front of technically qualified audience

Guidelines:

- The Project work will preferably be a problem with research potential and should involve scientific research, design, generation/collection and analysis of data, determining solution and must preferably bring out the individual contribution.
- Seminar should be based on the area in which the candidate has undertaken the dissertation work.
- The CIE shall include reviews and the preparation of report consisting of a detailed problem statement and a literature review.
- The preliminary results (if available) of the problem may also be discussed in the report.
- The work has to be presented in front of the committee consists of Chairperson-BoS, Osmania University and Head, Supervisor & Project coordinator from the respective Department of the Institute.
- The candidate has to be in regular contact with his supervisor and the topic of dissertation must be mutually decided by the guide and student.

Guidelines for awarding marks in CIE (Continuous Internal Evaluation): Max. Marks: 100				
Evaluation by	Max. Marks	Evaluation Criteria /		
		Parameter		
Supervisor	30	Project Status / Review(s)		
Supervisor	20	Report		
Departmental Committee	10	Relevance of the Topic		
(Chairperson BoS,	10	PPT Preparation		
Osmania University and	10	Presentation		
Head, Supervisor & Project coordinator from	10	Question and Answers		
the respective department of the institution)	10	Report Preparation		

Note: The Supervisor has to assess the progress of the student regularly.

SEMESTER – IV

EC 182

MAJOR PROJECT PHASE - II

*Instruction: 32 periods per week*Duration of SEE: --

CIE: -- SEE: 200 marks

Credits: 16

Outcomes: At the end of this course, students will be able to:

- 1. Use different experimental techniques and will be able to use different software/computational/analytical tools.
- 2. Design and develop an experimental set up/equipment/test rig.
- 3. Conduct tests on existing set ups/equipment's and draw logical conclusions from the results after analysing them.
- 4. Either work in a research environment or in an industrial environment.
- 5. Conversant with technical report writing and will be able to present and convince their topic of study to the engineering community.

Guidelines:

- It is a continuation of Major Project Phase I started in semester III.
- The student has to submit the report in prescribed format and also present a seminar.
- The dissertation should be presented in standard format as provided by the department.
- The candidate has to prepare a detailed project report consisting of introduction of the problem, problem statement, literature review, objectives of the work, methodology (experimental set up or numerical details as the case may be) of solution and results and discussion.
- The report must bring out the conclusions of the work and future scope for the study. The work has to be presented in front of the examiners panel consisting of an approved external examiner and Chairperson BoS, & Head, Osmania University and Supervisor from the Institute.
- The candidate has to be in regular contact with his/her Supervisor / Co- Supervisor

Guidelines for awarding marks in SEE (Semester End Examination): Max. Marks: 200				
Evaluation by	Max. Marks	Evaluation Criteria / Parameter		
Supervisor	10	Regularity and Punctuality		
	10	Work Progress		
	30	Quality of the work which may lead to publications		
	10	Analytical / Programming / Experimental Skills Preparation		
	10	Report preparation in a standard format		
External Examiner and	20	Power Point Presentation		
Chairperson, BoS & Head,	60	Quality of thesis and evaluation		
Osmania University (All together	30	Innovations, application to society and Scope for future study		
	20	Viva-Voce		

With effect from academic year 2021-22